



# PCF85063A

## Tiny Real-Time Clock/calendar with alarm function and I<sup>2</sup>C-bus

Rev. 7 — 30 March 2018

Product data sheet

### 1. General description

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The PCF85063A is a CMOS<sup>1</sup> Real-Time Clock (RTC) and calendar optimized for low power consumption. An offset register allows fine-tuning of the clock. All addresses and data are transferred serially via the two-line bidirectional I<sup>2</sup>C-bus. Maximum data rate is 400 kbit/s. The register address is incremented automatically after each written or read data byte.

For a selection of NXP Real-Time Clocks, see [Table 45 on page 56](#)

### 2. Features and benefits

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- Provides year, month, day, weekday, hours, minutes, and seconds based on a 32.768 kHz quartz crystal
- Clock operating voltage: 0.9 V to 5.5 V
- Low current; typical 0.22  $\mu$ A at  $V_{DD} = 3.3$  V and  $T_{amb} = 25$  °C
- 400 kHz two-line I<sup>2</sup>C-bus interface (at  $V_{DD} = 1.8$  V to 5.5 V)
- Programmable clock output for peripheral devices (32.768 kHz, 16.384 kHz, 8.192 kHz, 4.096 kHz, 2.048 kHz, 1.024 kHz, and 1 Hz)
- Selectable integrated oscillator load capacitors for  $C_L = 7$  pF or  $C_L = 12.5$  pF
- Alarm function
- Countdown timer
- Minute and half minute interrupt
- Oscillator stop detection function
- Internal Power-On Reset (POR)
- Programmable offset register for frequency adjustment

### 3. Applications

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- Digital still camera
- Digital video camera
- Printers
- Copy machines
- Mobile equipment
- Battery powered devices

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1. The definition of the abbreviations and acronyms used in this data sheet can be found in [Section 21](#).



## 4. Ordering information

Table 1. Ordering information

| Type number | Package    |  |           |
|-------------|------------|--|-----------|
|             | Name       | Description  | Version   |
| PCF85063AT  | SO8        | plastic small outline package; 8 leads; body width 3.9 mm  | SOT96-1   |
| PCF85063ATL | DFN2626-10 | plastic thermal enhanced extremely thin small outline package; no leads; 10 terminals; body 2.6 × 2.6 × 0.5 mm | SOT1197-1 |
| PCF85063ATT | TSSOP8     | plastic thin shrink small outline package; 8 leads; body width 3 mm  | SOT505-1  |

### 4.1 Ordering options

Table 2. Ordering options

| Product type number | Orderable part number | Sales item (12NC) | Delivery form                    | IC revision |
|---------------------|-----------------------|-------------------|----------------------------------|-------------|
| PCF85063AT/A        | PCF85063AT/AY         | 935303639518      | tape and reel, 13 inch, dry pack | 1           |
|                     | PCF85063AT/AAZ        | 935303639515      | tape and reel, 7 inch, dry pack  | 1           |
| PCF85063ATL/1       | PCF85063ATL/1,118     | 935299022118      | tape and reel, 7 inch            | 1           |
| PCF85063ATT/A       | PCF85063ATT/AJ        | 935304639118      | tape and reel, 13 inch           | 1           |

## 5. Marking

Table 3. Marking codes

| Product type number | Marking code |
|---------------------|--------------|
| PCF85063AT/A        | 85063A       |
| PCF85063ATL/1       | 063A         |
| PCF85063ATT/A       | 063A         |

## 6. Block diagram

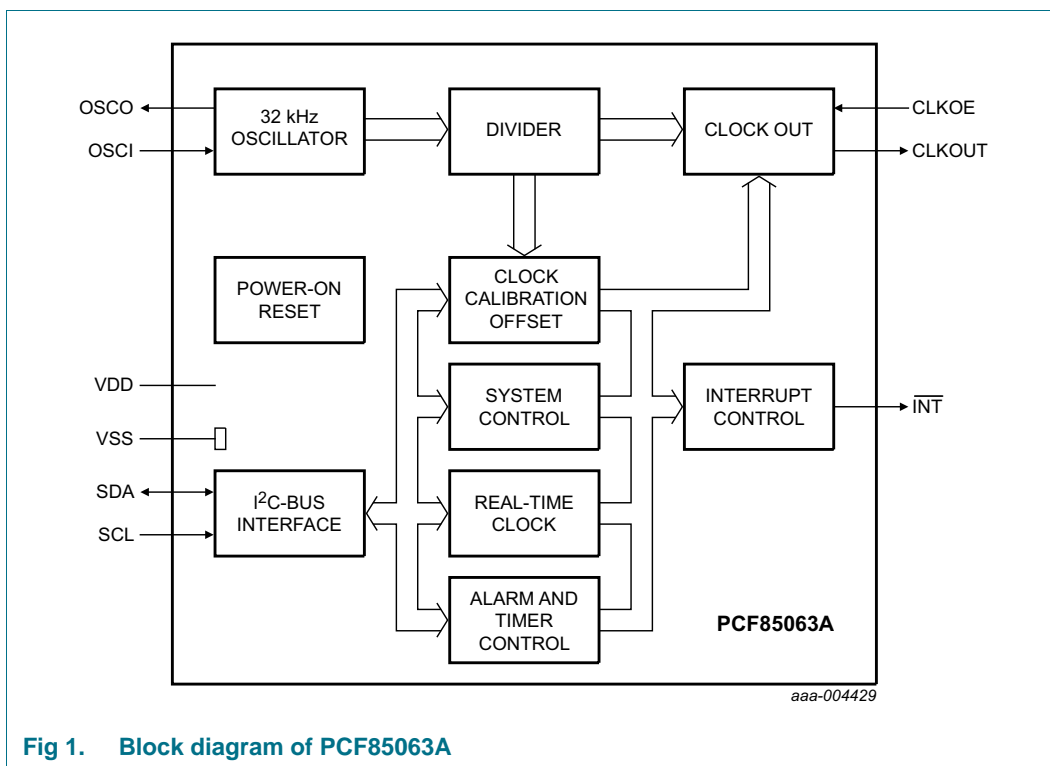
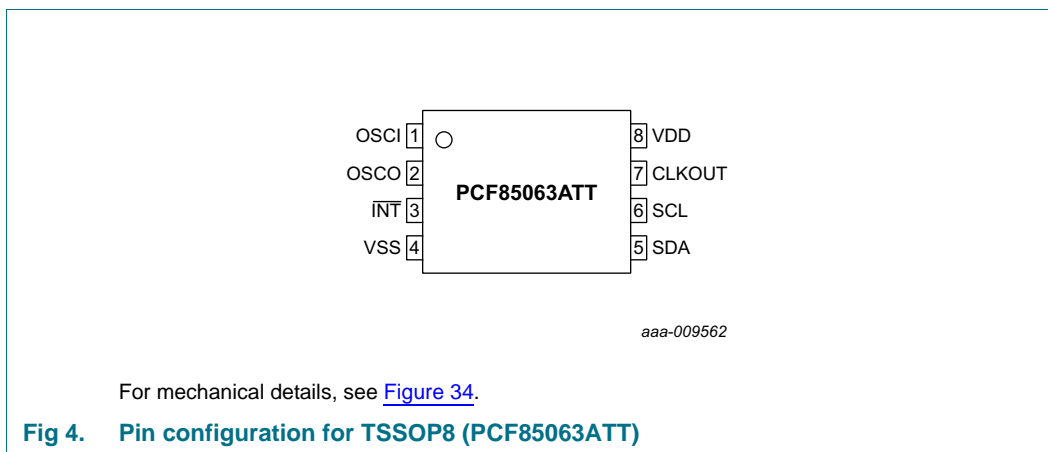
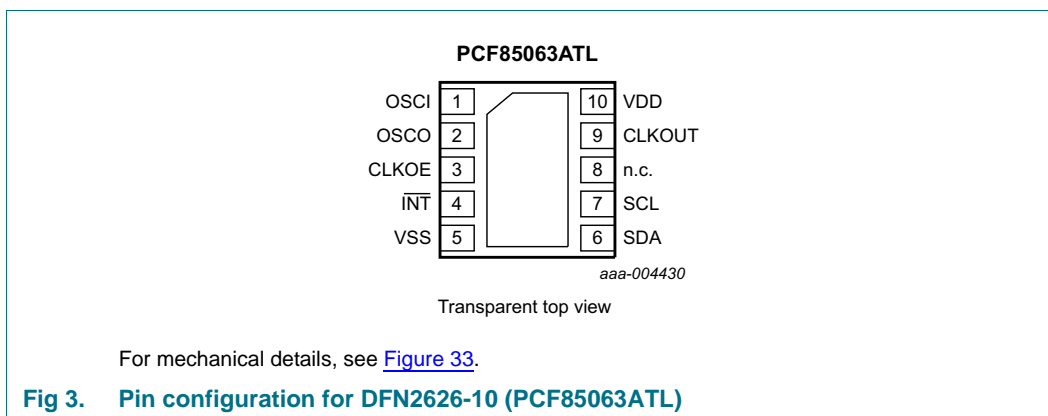
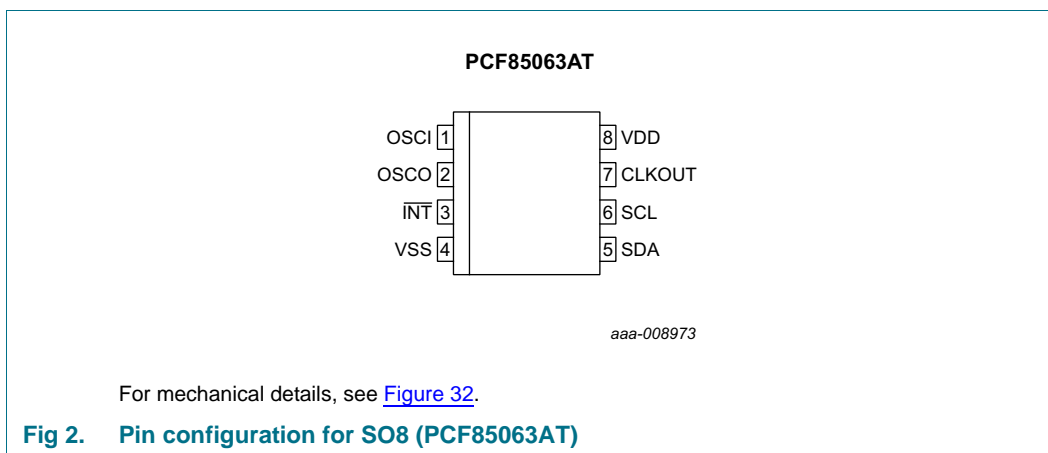


Fig 1. Block diagram of PCF85063A

## 7. Pinning information

### 7.1 Pinning



## 7.2 Pin description

**Table 4. Pin description**

*Input or input/output pins must always be at a defined level ( $V_{SS}$  or  $V_{DD}$ ) unless otherwise specified.*

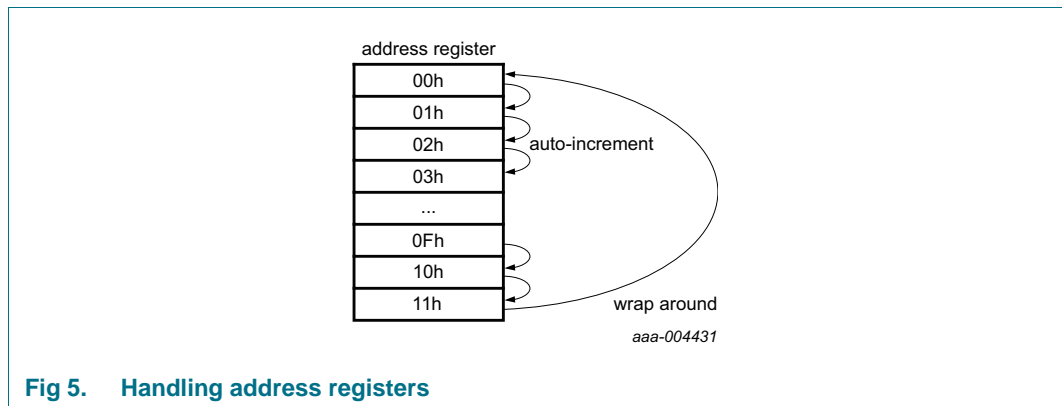
| Symbol                                 | Pin        |                  |             | Type         | Description   |
|--|------------|------------------|-------------|--------------|---|
|  | PCF85063AT | PCF85063ATL      | PCF85063ATT |              |   |
| OSCI                                   | 1          | 1                | 1           | input        | oscillator input                                    |
| OSCO                                   | 2          | 2                | 2           | output       | oscillator output                                   |
| CLKOE <sup>[2]</sup>                   | -          | 3                | -           | input        | CLKOUT enable or disable pin; enable is active HIGH |
| $\overline{\text{INT}}$ <sup>[2]</sup> | 3          | 4                | 3           | output       | interrupt output (open-drain)                       |
| VSS                                    | 4          | 5 <sup>[1]</sup> | 4           | supply       | ground supply voltage                               |
| SDA <sup>[2]</sup>                     | 5          | 6                | 5           | input/output | serial data line                                    |
| SCL <sup>[2]</sup>                     | 6          | 7                | 6           | input        | serial clock input                                  |
| n.c.                                   | -          | 8                | -           | -            | not connected                                       |
| CLKOUT                                 | 7          | 9                | 7           | output       | clock output (push-pull)                            |
| VDD                                    | 8          | 10               | 8           | supply       | supply voltage                                      |

- [1] The die paddle (exposed pad) is connected to  $V_{SS}$  through high ohmic (non-conductive) silicon attach and should be electrically isolated. It is good engineering practice to solder the exposed pad to an electrically isolated PCB copper pad as shown in [Figure 37 "Footprint information for reflow soldering of SOT1197-1 \(DFN2626-10\) of PCF85063ATL"](#) for better heat transfer but it is not required as the RTC doesn't consume much power. In no case should traces be run under the package exposed pad.
- [2] NXP recommends tying VDD of the device and VDD of all the external pull-up resistors to the same Power Supply.

## 8. Functional description

The PCF85063A contains 18 8-bit registers with an auto-incrementing register address, an on-chip 32.768 kHz oscillator with integrated capacitors, a frequency divider which provides the source clock for the Real-Time Clock (RTC) and calendar, and an I<sup>2</sup>C-bus interface with a maximum data rate of 400 kbit/s.

The built-in address register will increment automatically after each read or write of a data byte up to the register 11h. After register 11h, the auto-incrementing will wrap around to address 00h (see [Figure 5](#)).



**Fig 5. Handling address registers**

All registers (see [Table 5](#)) are designed as addressable 8-bit parallel registers although not all bits are implemented. The first two registers (memory address 00h and 01h) are used as control and status register. The register at address 02h is an offset register allowing the fine-tuning of the clock; and at 03h is a free RAM byte. The addresses 04h through 0Ah are used as counters for the clock function (seconds up to years counters). Address locations 0Bh through 0Fh contain alarm registers which define the conditions for an alarm. The registers at 10h and 11h are for the timer function.

The Seconds, Minutes, Hours, Days, Months, and Years as well as the corresponding alarm registers are all coded in Binary Coded Decimal (BCD) format. When one of the RTC registers is written or read, the contents of all time counters are frozen. Therefore, faulty writing or reading of the clock and calendar during a carry condition is prevented. For details on maximum access time, see [Section 8.4 on page 25](#).

## 8.1 Registers organization

**Table 5. Registers overview**

Bit positions labeled as - are not implemented. After reset, all registers are set according to [Table 8 on page 12](#).

| Address                      | Register name | Bit             |                        |                                      |                                      |    |                        |       |         | Reference                     |                               |
|------------------------------|---------------|-----------------|------------------------|--------------------------------------|--------------------------------------|----|------------------------|-------|---------|-------------------------------|-------------------------------|
|                              |               | 7               | 6                      | 5                                    | 4                                    | 3  | 2                      | 1     | 0       |                               |                               |
| Control and status registers |               |                 |                        |                                      |                                      |    |                        |       |         |                               |                               |
| 00h                          | Control_1     | EXT_TEST        | -                      | STOP                                 | SR                                   | -  | CIE                    | 12_24 | CAP_SEL | <a href="#">Section 8.2.1</a> |                               |
| 01h                          | Control_2     | AIE             | AF                     | MI                                   | HMI                                  | TF | COF[2:0]               |       |         | <a href="#">Section 8.2.2</a> |                               |
| 02h                          | Offset        | MODE            | OFFSET[6:0]            |                                      |                                      |    |                        |       |         |                               | <a href="#">Section 8.2.3</a> |
| 03h                          | RAM_byte      | B[7:0]          |                        |                                      |                                      |    |                        |       |         | <a href="#">Section 8.2.4</a> |                               |
| Time and date registers      |               |                 |                        |                                      |                                      |    |                        |       |         |                               |                               |
| 04h                          | Seconds       | OS              | SECONDS (0 to 59)      |                                      |                                      |    |                        |       |         |                               | <a href="#">Section 8.3.1</a> |
| 05h                          | Minutes       | -               | MINUTES (0 to 59)      |                                      |                                      |    |                        |       |         |                               | <a href="#">Section 8.3.2</a> |
| 06h                          | Hours         | -               | -                      | AMPM                                 | HOURS (1 to 12) in 12-hour mode      |    |                        |       |         | <a href="#">Section 8.3.3</a> |                               |
|                              |               |                 |                        | HOURS (0 to 23) in 24-hour mode      |                                      |    |                        |       |         |                               |                               |
| 07h                          | Days          | -               | -                      | DAYS (1 to 31)                       |                                      |    |                        |       |         | <a href="#">Section 8.3.4</a> |                               |
| 08h                          | Weekdays      | -               | -                      | -                                    | -                                    | -  | WEEKDAYS (0 to 6)      |       |         | <a href="#">Section 8.3.5</a> |                               |
| 09h                          | Months        | -               | -                      | -                                    | MONTHS (1 to 12)                     |    |                        |       |         |                               | <a href="#">Section 8.3.6</a> |
| 0Ah                          | Years         | YEARS (0 to 99) |                        |                                      |                                      |    |                        |       |         | <a href="#">Section 8.3.7</a> |                               |
| Alarm registers              |               |                 |                        |                                      |                                      |    |                        |       |         |                               |                               |
| 0Bh                          | Second_alarm  | AEN_S           | SECOND_ALARM (0 to 59) |                                      |                                      |    |                        |       |         |                               | <a href="#">Section 8.5.1</a> |
| 0Ch                          | Minute_alarm  | AEN_M           | MINUTE_ALARM (0 to 59) |                                      |                                      |    |                        |       |         |                               | <a href="#">Section 8.5.2</a> |
| 0Dh                          | Hour_alarm    | AEN_H           | -                      | AMPM                                 | HOUR_ALARM (1 to 12) in 12-hour mode |    |                        |       |         | <a href="#">Section 8.5.3</a> |                               |
|                              |               |                 |                        | HOUR_ALARM (0 to 23) in 24-hour mode |                                      |    |                        |       |         |                               |                               |
| 0Eh                          | Day_alarm     | AEN_D           | -                      | DAY_ALARM (1 to 31)                  |                                      |    |                        |       |         | <a href="#">Section 8.5.4</a> |                               |
| 0Fh                          | Weekday_alarm | AEN_W           | -                      | -                                    | -                                    | -  | WEEKDAY_ALARM (0 to 6) |       |         | <a href="#">Section 8.5.5</a> |                               |
| Timer registers              |               |                 |                        |                                      |                                      |    |                        |       |         |                               |                               |
| 10h                          | Timer_value   | T[7:0]          |                        |                                      |                                      |    |                        |       |         | <a href="#">Section 8.6.1</a> |                               |
| 11h                          | Timer_mode    | -               | -                      | -                                    | TCF[1:0]                             |    | TE                     | TIE   | TI_TP   | <a href="#">Section 8.6.2</a> |                               |

## 8.2 Control registers

To ensure that all control registers will be set to their default values, the V<sub>DD</sub> level must be at zero volts at initial power-up. If this is not possible, a reset must be initiated with the software reset command when power is stable. Refer to [Section 8.2.1.3](#) for details.

### 8.2.1 Register Control\_1

Table 6. Control\_1 - control and status register 1 (address 00h) bit description

| Bit | Symbol   | Value            | Description  | Reference  |
|-----|----------|------------------|--|--|
| 7   | EXT_TEST |                  | <b>external clock test mode</b>  | <a href="#">Section 8.2.1.1</a>                                |
|     |          | 0 <sup>[1]</sup> | normal mode  |  |
|     |          | 1                | external clock test mode   |  |
| 6   | -        | 0                | unused   | -  |
| 5   | STOP     |                  | <b>STOP bit</b>  | <a href="#">Section 8.2.1.2</a>                                |
|     |          | 0 <sup>[1]</sup> | RTC clock runs   |  |
|     |          | 1                | RTC clock is stopped; all RTC divider chain flip-flops are asynchronously set logic 0                    |  |
| 4   | SR       |                  | <b>software reset</b>  | <a href="#">Section 8.2.1.3</a>                                |
|     |          | 0 <sup>[1]</sup> | no software reset  |  |
|     |          | 1                | initiate software reset <sup>[2]</sup> ; this bit always returns a 0 when read                           |  |
| 3   | -        | 0                | unused   | -  |
| 2   | CIE      |                  | <b>correction interrupt enable</b>   | <a href="#">Section 8.2.3</a>                                  |
|     |          | 0 <sup>[1]</sup> | no correction interrupt generated  |  |
|     |          | 1                | interrupt pulses are generated at every correction cycle   |  |
| 1   | 12_24    |                  | <b>12 or 24-hour mode</b>  | <a href="#">Section 8.3.3</a><br><a href="#">Section 8.5.3</a> |
|     |          | 0 <sup>[1]</sup> | 24-hour mode is selected   |  |
|     |          | 1                | 12-hour mode is selected   |  |
| 0   | CAP_SEL  |                  | <b>internal oscillator capacitor selection</b> for quartz crystals with a corresponding load capacitance | -  |
|     |          | 0 <sup>[1]</sup> | 7 pF   |  |
|     |          | 1                | 12.5 pF  |  |

[1] Default value.

[2] For a software reset, 01011000 (58h) must be sent to register Control\_1 (see [Section 8.2.1.3](#)).



#### 8.2.1.1 EXT\_TEST: external clock test mode

A test mode is available which allows for on-board testing. In this mode, it is possible to set up test conditions and control the operation of the RTC.

The test mode is entered by setting bit EXT\_TEST in register Control\_1. Then pin CLKOUT becomes an input. The test mode replaces the internal clock signal with the signal applied to pin CLKOUT.

The signal applied to pin CLKOUT should have a minimum pulse width of 300 ns and a maximum period of 1 000 ns. The internal clock, now sourced from CLKOUT, is divided down to 1 Hz by a 2<sup>6</sup> divide chain called a prescaler. The prescaler can be set into a known state by using bit STOP. When bit STOP is set, the prescaler is reset to 0. (STOP must be cleared before the prescaler can operate again.)

From a stop condition, the first 1 second increment will take place after 32 positive edges on pin CLKOUT. Thereafter, every 64 positive edges cause a 1 second increment.

**Remark:** Entry into test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the prescaler can be made.

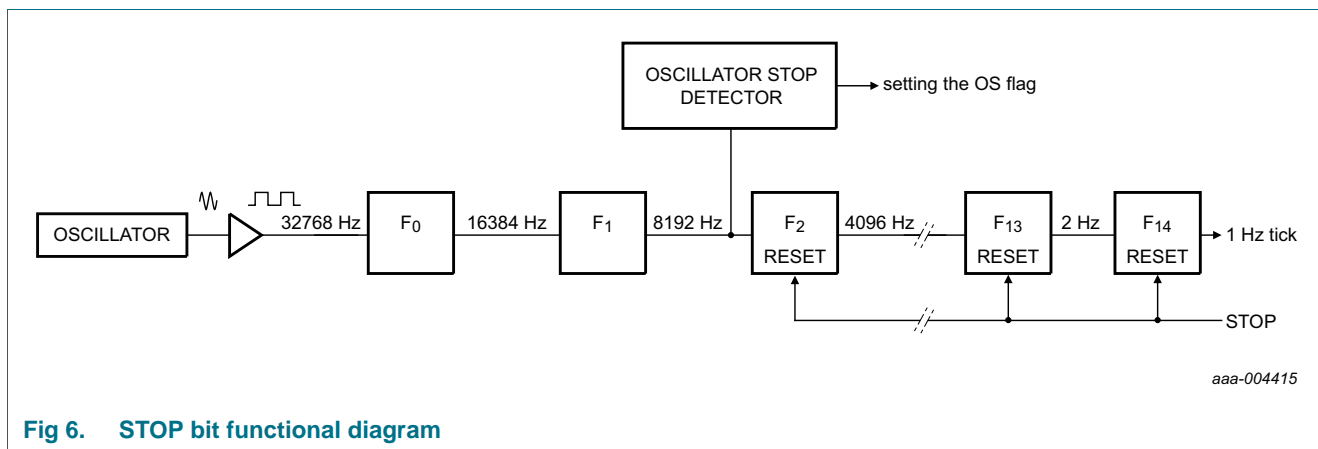
Operation example:

1. Set EXT\_TEST test mode (register Control\_1, bit EXT\_TEST = 1).
2. Set STOP (register Control\_1, bit STOP = 1).
3. Clear STOP (register Control\_1, bit STOP = 0).
4. Set time registers to desired value.
5. Apply 32 clock pulses to pin CLKOUT.
6. Read time registers to see the first change.
7. Apply 64 clock pulses to pin CLKOUT.
8. Read time registers to see the second change.

Repeat 7 and 8 for additional increments.

### 8.2.1.2 STOP: STOP bit function

The function of the STOP bit (see [Figure 6](#)) is to allow for accurate starting of the time circuits. The STOP bit function causes the upper part of the prescaler ( $F_2$  to  $F_{14}$ ) to be held in reset and thus no 1 Hz ticks are generated. It also stops the output of clock frequencies below 8 kHz on pin CLKOUT.



**Fig 6. STOP bit functional diagram**

The time circuits can then be set and do not increment until the STOP bit is released (see [Figure 7](#) and [Table 7](#)).

Table 7. First increment of time circuits after STOP bit release

| Bit  | Prescaler bits   | [1] 1 Hz tick | Time     | Comment   |
|--|--|---------------|----------|---|
| STOP   | F <sub>0</sub> F <sub>1</sub> -F <sub>2</sub> to F <sub>14</sub> |               | hh:mm:ss |   |
| <b>Clock is running normally</b>   |  |               |          |   |
| 0  | 01-0 0001 1101 0100  |               | 12:45:12 | prescaler counting normally                                       |
| <b>STOP bit is activated by user. F<sub>0</sub>F<sub>1</sub> are not reset and values cannot be predicted externally</b> |  |               |          |   |
| 1  | XX-0 0000 0000 0000  |               | 12:45:12 | prescaler is reset; time circuits are frozen                      |
| <b>New time is set by user</b>   |  |               |          |   |
| 1  | XX-0 0000 0000 0000  |               | 08:00:00 | prescaler is reset; time circuits are frozen                      |
| <b>STOP bit is released by user</b>  |  |               |          |   |
| 0  | XX-0 0000 0000 0000  |               | 08:00:00 | prescaler is now running  |
|  | XX-1 0000 0000 0000  |               | 08:00:00 | -   |
|  | XX-0 1000 0000 0000  |               | 08:00:00 | -   |
|  | XX-1 1000 0000 0000  |               | 08:00:00 | -   |
|  | :  |               | :        | :   |
|  | 11-1 1111 1111 1110  |               | 08:00:00 | -   |
|  | 00-0 0000 0000 0001  |               | 08:00:01 | 0 to 1 transition of F <sub>14</sub> increments the time circuits |
|  | 10-0 0000 0000 0001  |               | 08:00:01 | -   |
|  | :  |               | :        | :   |
|  | 11-1 1111 1111 1111  |               | 08:00:01 | -   |
|  | 00-0 0000 0000 0000  |               | 08:00:01 | -   |
|  | 10-0 0000 0000 0000  |               | 08:00:01 | -   |
|  | :  |               | :        | :   |
|  | 11-1 1111 1111 1110  |               | 08:00:01 | -   |
|  | 00-0 0000 0000 0001  |               | 08:00:02 | 0 to 1 transition of F <sub>14</sub> increments the time circuits |
|  |  |               |          |   |
|  |  |               |          |   |
|  |  |               |          |   |
|  |  |               |          |   |
|  |  |               |          |   |

[1] F<sub>0</sub> is clocked at 32.768 kHz.

The lower two stages of the prescaler (F<sub>0</sub> and F<sub>1</sub>) are not reset. And because the I<sup>2</sup>C-bus is asynchronous to the crystal oscillator, the accuracy of restarting the time circuits is between zero and one 8.192 kHz cycle (see [Figure 7](#)).

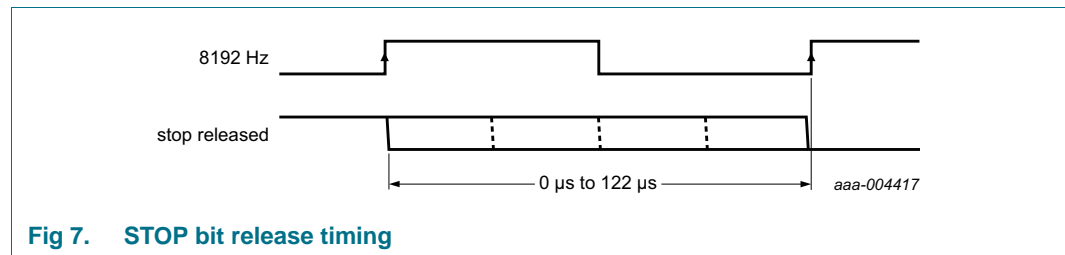
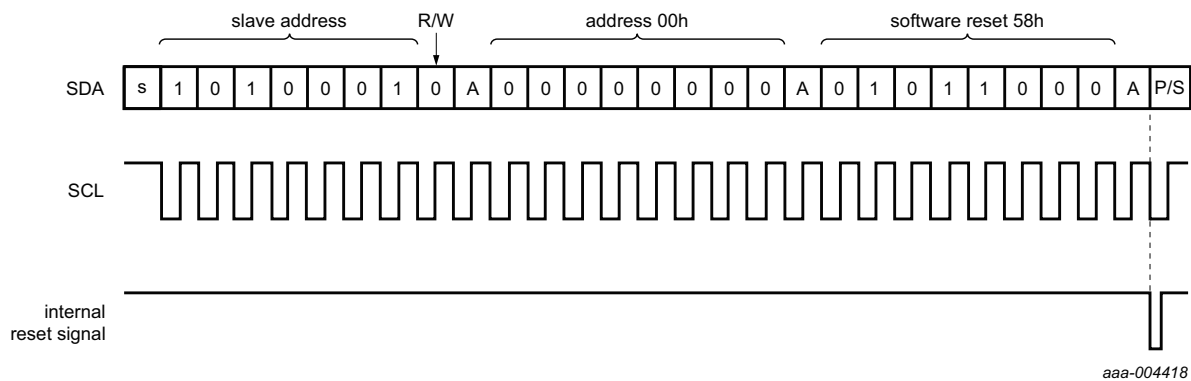


Fig 7. STOP bit release timing

The first increment of the time circuits is between 0.507813 s and 0.507935 s after STOP bit is released. The uncertainty is caused by the prescaler bits F<sub>0</sub> and F<sub>1</sub> not being reset (see [Table 7](#)) and the unknown state of the 32 kHz clock.

### 8.2.1.3 Software reset

A reset is automatically generated at power-on. There is a low probability that some devices will have corruption of the registers after the automatic power-on reset if the device is powered up with a residual  $V_{DD}$  level. It is required that the  $V_{DD}$  starts at zero volts at power up or upon power cycling to ensure that there is no corruption of the registers. If this is not possible, a reset must be initiated after power-up (i.e. when power is stable) with the software reset command. Software reset command means setting bits 6, 4, and 3 in register Control\_1 (00h) logic 1 and all other bits logic 0 by sending the bit sequence 01011000 (58h), see [Figure 8](#).



After sending the software reset command, it is recommended to re-initialize the interface by a STOP and START.

**Fig 8. Software reset command**

In reset state, all registers are set according to [Table 8](#) and the address pointer returns to address 00h.

**Table 8. Registers reset values**

| Address | Register name | Bit |   |   |   |   |   |   |   |
|---------|---------------|-----|---|---|---|---|---|---|---|
|         |               | 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 00h     | Control_1     | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 01h     | Control_2     | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 02h     | Offset        | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 03h     | RAM_byte      | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 04h     | Seconds       | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 05h     | Minutes       | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 06h     | Hours         | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 07h     | Days          | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 08h     | Weekdays      | 0   | 0 | 0 | 0 | 0 | 1 | 1 | 0 |
| 09h     | Months        | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 0Ah     | Years         | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0Bh     | Second_alarm  | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0Ch     | Minute_alarm  | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0Dh     | Hour_alarm    | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0Eh     | Day_alarm     | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Table 8. Registers reset values ...continued

| Address | Register name | Bit |   |   |   |   |   |   |   |
|---------|---------------|-----|---|---|---|---|---|---|---|
|         |               | 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0Fh     | Weekday_alarm | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 10h     | Timer_value   | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 11h     | Timer_mode    | 0   | 0 | 0 | 1 | 1 | 0 | 0 | 0 |

The PCF85063A resets to:

**Time** — 00:00:00

**Date** — 20000101

**Weekday** — Saturday

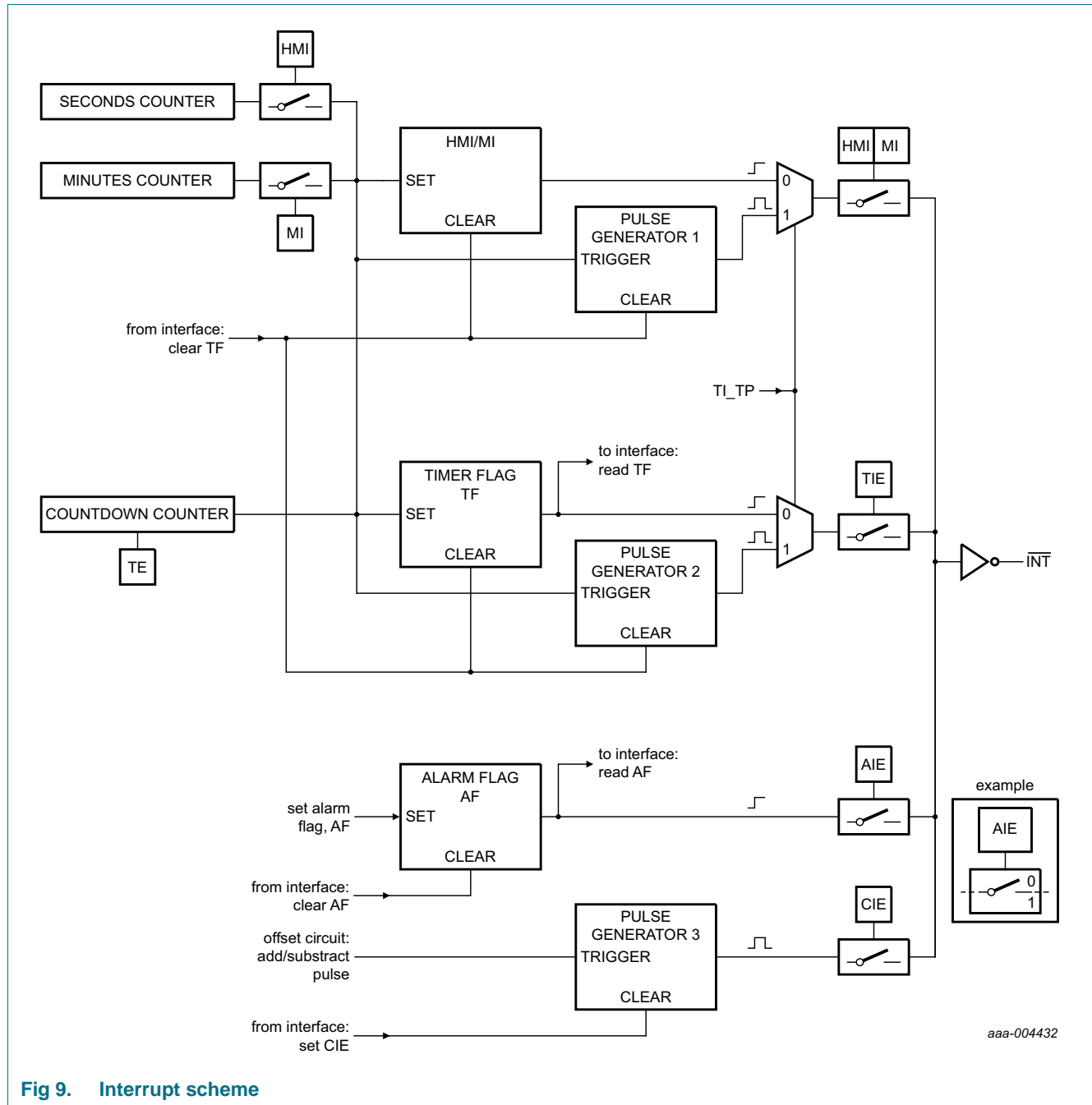
## 8.2.2 Register Control\_2

Table 9. Control\_2 - control and status register 2 (address 01h) bit description

| Bit    | Symbol   | Value                        | Description                             | Reference   |
|--------|----------|------------------------------|---|---|
| 7      | AIE      |                              | <b>alarm interrupt</b>                  | <a href="#">Section 8.2.2.1</a><br><a href="#">Section 8.5.6</a>                                    |
|        |          | 0[1]                         | disabled                                |   |
|        |          | 1                            | enabled                                 |   |
| 6      | AF       |                              | <b>alarm flag</b>                       | <a href="#">Section 8.2.2.1</a><br><a href="#">Section 8.5.6</a>                                    |
|        |          | 0[1]                         | read: alarm flag inactive               |   |
|        |          |                              | write: alarm flag is cleared            |   |
|        |          | 1                            | read: alarm flag active                 |   |
|        |          |                              | write: alarm flag remains unchanged     |   |
| 5      | MI       |                              | <b>minute interrupt</b>                 | <a href="#">Section 8.2.2.2</a><br><a href="#">Section 8.2.2.3</a>                                  |
|        |          | 0[1]                         | disabled                                |   |
|        |          | 1                            | enabled                                 |   |
| 4      | HMI      |                              | <b>half minute interrupt</b>            | <a href="#">Section 8.2.2.2</a><br><a href="#">Section 8.2.2.3</a>                                  |
|        |          | 0[1]                         | disabled                                |   |
|        |          | 1                            | enabled                                 |   |
| 3      | TF       |                              | <b>timer flag</b>                       | <a href="#">Section 8.2.2.1</a><br><a href="#">Section 8.2.2.3</a><br><a href="#">Section 8.6.3</a> |
|        |          | 0[1]                         | no timer interrupt generated            |   |
|        |          | 1                            | flag set when timer interrupt generated |   |
| 2 to 0 | COF[2:0] | see <a href="#">Table 11</a> | <b>CLKOUT control</b>                   | <a href="#">Section 8.2.2.4</a>   |

[1] Default value.

### 8.2.2.1 Alarm interrupt



**AIE:** This bit activates or deactivates the generation of an interrupt when AF is asserted, respectively.

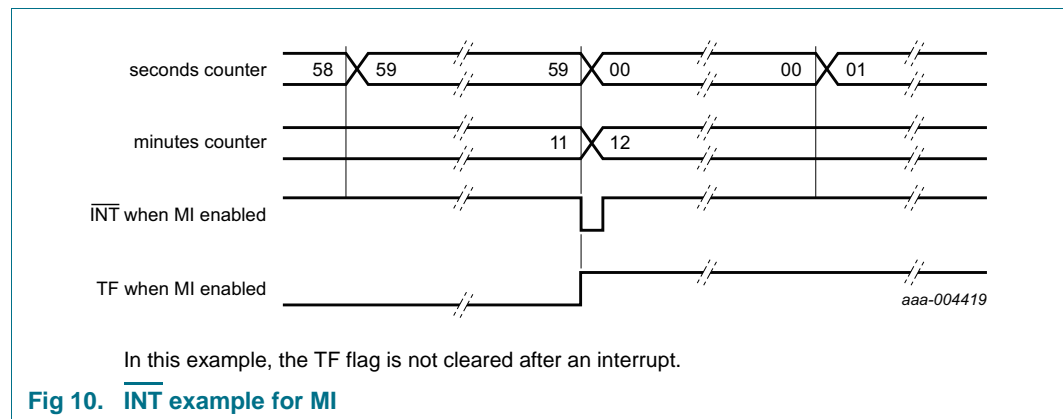
**AF:** When an alarm occurs, AF is set logic 1. This bit maintains its value until overwritten by command. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access.

### 8.2.2.2 MI and HMI: minute and half minute interrupt

The minute interrupt (bit MI) and half minute interrupt (bit HMI) are pre-defined timers for generating interrupt pulses on pin  $\overline{\text{INT}}$ ; see [Figure 10](#). The timers are running in sync with the seconds counter (see [Table 19 on page 21](#)).

The minute and half minute interrupts must only be used when the frequency offset is set to normal mode (MODE = 0), see [Section 8.2.3](#). In normal mode, the interrupt pulses on pin  $\overline{\text{INT}}$  are  $\frac{1}{64}$  s wide.

When starting MI, the first interrupt will be generated after 1 second to 59 seconds. When starting HMI, the first interrupt will be generated after 1 second to 29 seconds. Subsequent periods do not have such a delay. The timers can be enabled independently from one another. However, a minute interrupt enabled on top of a half minute interrupt is not distinguishable.



**Table 10. Effect of bits MI and HMI on  $\overline{\text{INT}}$  generation**

| Minute interrupt (bit MI) | Half minute interrupt (bit HMI) | Result                    |
|---------------------------|---------------------------------|---------------------------|
| 0                         | 0                               | no interrupt generated    |
| 1                         | 0                               | an interrupt every minute |
| 0                         | 1                               | an interrupt every 30 s   |
| 1                         | 1                               | an interrupt every 30 s   |

The duration of the timer is affected by the register Offset (see [Section 8.2.3](#)). Only when OFFSET[6:0] has the value 00h the periods are consistent.

### 8.2.2.3 TF: timer flag

The timer flag (bit TF) is set logic 1 on the first trigger of MI, HMI, or the countdown timer. The purpose of the flag is to allow the controlling system to interrogate what caused the interrupt: timer or alarm. The flag can be read and cleared by command.

The status of the timer flag TF can affect the  $\overline{\text{INT}}$  pulse generation depending on the setting of TI\_TP (see [Section 8.6.2 "Register Timer\\_mode" on page 30](#)):

- When TI\_TP is set logic 1
  - an  $\overline{\text{INT}}$  pulse is generated independent of the status of the timer flag TF
  - TF stays set until it is cleared
  - TF does not affect  $\overline{\text{INT}}$

- the countdown timer runs in a repetitive loop and keeps generating timed periods
- When TI\_TP is set logic 0
  - the  $\overline{\text{INT}}$  generation follows the TF flag
  - TF stays set until it is cleared
  - If TF is not cleared before the next coming interrupt, no  $\overline{\text{INT}}$  is generated
  - the countdown timer stops after the first countdown

#### 8.2.2.4 COF[2:0]: Clock output frequency

A programmable square wave is available at pin CLKOUT. Operation is controlled by the COF[2:0] bits in the register Control\_2. Frequencies of 32.768 kHz (default) down to 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator.

Pin CLKOUT is a push-pull output and enabled at power-on. CLKOUT can be disabled by setting COF[2:0] to 111 or by setting CLKOE LOW (PCF85063ATL only). When disabled, the CLKOUT is LOW. If CLKOE is HIGH and COF[2:0]=111 there will be no clock and CLKOUT will be LOW.

The duty cycle of the selected clock is not controlled. However, due to the nature of the clock generation, all clock frequencies except 32.768 kHz have a duty cycle of 50 : 50.

The STOP bit function can also affect the CLKOUT signal, depending on the selected frequency. When the STOP bit is set logic 1, the CLKOUT pin generates a continuous LOW for those frequencies that can be stopped. For more details of the STOP bit function, see [Section 8.2.1.2](#).

**Table 11. CLKOUT frequency selection**

| COF[2:0]           | CLKOUT frequency (Hz) | Typical duty cycle <sup>[1]</sup> | Effect of STOP bit |
|--------------------|-----------------------|-----------------------------------|--------------------|
| 000 <sup>[2]</sup> | 32768                 | 60 : 40 to 40 : 60                | no effect          |
| 001                | 16384                 | 50 : 50                           | no effect          |
| 010                | 8192                  | 50 : 50                           | no effect          |
| 011                | 4096                  | 50 : 50                           | CLKOUT = LOW       |
| 100                | 2048                  | 50 : 50                           | CLKOUT = LOW       |
| 101                | 1024                  | 50 : 50                           | CLKOUT = LOW       |
| 110                | 1 <sup>[3]</sup>      | 50 : 50                           | CLKOUT = LOW       |
| 111                | CLKOUT = LOW          | -                                 | -                  |

[1] Duty cycle definition: % HIGH-level time : % LOW-level time.

[2] Default values: The duty cycle of the CLKOUT when outputting 32,768 Hz could change from 60:40 to 40:60 depending on the detector since the 32,768 Hz is derived from the oscillator output which is not perfect. It could change from device to device and it depends on the silicon diffusion. There is nothing that can be done from outside the chip to influence the duty cycle.

[3] 1 Hz clock pulses are affected by offset correction pulses.



### 8.2.3 Register Offset

The PCF85063A incorporates an offset register (address 02h) which can be used to implement several functions, such as:

- Accuracy tuning
- Aging adjustment
- Temperature compensation

**Table 12. Offset - offset register (address 02h) bit description**

| Bit    | Symbol      | Value                        | Description                                      |
|--------|-------------|------------------------------|--|
| 7      | MODE        |                              | <b>offset mode</b>                               |
|        |             | 0 <sup>[1]</sup>             | normal mode: offset is made once every two hours |
|        |             | 1                            | course mode: offset is made every 4 minutes      |
| 6 to 0 | OFFSET[6:0] | see <a href="#">Table 13</a> | <b>offset value</b>                              |

[1] Default value.

For MODE = 0, each LSB introduces an offset of 4.34 ppm. For MODE = 1, each LSB introduces an offset of 4.069 ppm. The offset value is coded in two's complement giving a range of +63 LSB to -64 LSB.

**Table 13. Offset values**

| OFFSET[6:0]            | Offset value in decimal | Offset value in ppm     |                       |
|------------------------|-------------------------|-------------------------|-----------------------|
|                        |                         | Normal mode<br>MODE = 0 | Fast mode<br>MODE = 1 |
| 0111111                | +63                     | +273.420                | +256.347              |
| 0111110                | +62                     | +269.080                | +252.278              |
| :                      | :                       | :                       | :                     |
| 0000010                | +2                      | +8.680                  | +8.138                |
| 0000001                | +1                      | +4.340                  | +4.069                |
| 0000000 <sup>[1]</sup> | 0                       | 0 <sup>[1]</sup>        | 0 <sup>[1]</sup>      |
| 1111111                | -1                      | -4.340                  | -4.069                |
| 1111110                | -2                      | -8.680                  | -8.138                |
| :                      | :                       | :                       | :                     |
| 1000001                | -63                     | -273.420                | -256.347              |
| 1000000                | -64                     | -277.760                | -260.416              |

[1] Default value.

The correction is made by adding or subtracting clock correction pulses, thereby changing the period of a single second but not by changing the oscillator frequency.

It is possible to monitor when correction pulses are applied. To enable correction interrupt generation, bit CIE (register Control\_1) has to be set logic 1. At every correction cycle, a pulse is generated on pin INT. The pulse width depends on the correction mode. If multiple correction pulses are applied, an interrupt pulse is generated for each correction pulse applied.

### 8.2.3.1 Correction when MODE = 0

The correction is triggered once every two hours and then correction pulses are applied once per minute until the programmed correction values have been implemented.

**Table 14. Correction pulses for MODE = 0**

| Correction value | Update every n <sup>th</sup> hour | Minute             | Correction pulses on INT per minute <sup>[1]</sup> |
|------------------|-----------------------------------|--------------------|--|
| +1 or –1         | 2                                 | 00                 | 1  |
| +2 or –2         | 2                                 | 00 and 01          | 1  |
| +3 or –3         | 2                                 | 00, 01, and 02     | 1  |
| :                | :                                 | :                  | :  |
| +59 or –59       | 2                                 | 00 to 58           | 1  |
| +60 or –60       | 2                                 | 00 to 59           | 1  |
| +61 or –61       | 2                                 | 00 to 59           | 1  |
|                  | 2nd and next hour                 | 00                 | 1  |
| +62 or –62       | 2                                 | 00 to 59           | 1  |
|                  | 2nd and next hour                 | 00 and 01          | 1  |
| +63 or –63       | 02                                | 00 to 59           | 1  |
|                  | 2nd and next hour                 | 00, 01, and 02     | 1  |
| –64              | 02                                | 00 to 59           | 1  |
|                  | 2nd and next hour                 | 00, 01, 02, and 03 | 1  |

[1] The correction pulses on pin  $\overline{\text{INT}}$  are  $\frac{1}{64}$  s wide.

In MODE = 0, any timer or clock output using a frequency below 64 Hz is affected by the clock correction (see [Table 15](#)).

**Table 15. Effect of correction pulses on frequencies for MODE = 0**

| Frequency (Hz)            | Effect of correction |
|---------------------------|----------------------|
| <b>CLKOUT</b>             |                      |
| 32768                     | no effect            |
| 16384                     | no effect            |
| 8192                      | no effect            |
| 4096                      | no effect            |
| 2048                      | no effect            |
| 1024                      | no effect            |
| 1                         | affected             |
| <b>Timer source clock</b> |                      |
| 4096                      | no effect            |
| 64                        | no effect            |
| 1                         | affected             |
| $\frac{1}{60}$            | affected             |

### 8.2.3.2 Correction when MODE = 1

The correction is triggered once every four minutes and then correction pulses are applied once per second up to a maximum of 60 pulses. When correction values greater than 60 pulses are used, additional correction pulses are made in the 59<sup>th</sup> second.

Clock correction is made more frequently in MODE = 1; however, this can result in higher power consumption.

**Table 16. Correction pulses for MODE = 1**

| Correction value | Update every n <sup>th</sup> minute | Second         | Correction pulses on INT per second <sup>[1]</sup> |
|------------------|-------------------------------------|----------------|--|
| +1 or –1         | 2                                   | 00             | 1  |
| +2 or –2         | 2                                   | 00 and 01      | 1  |
| +3 or –3         | 2                                   | 00, 01, and 02 | 1  |
| :                | :                                   | :              | :  |
| +59 or –59       | 2                                   | 00 to 58       | 1  |
| +60 or –60       | 2                                   | 00 to 59       | 1  |
| +61 or –61       | 2                                   | 00 to 58       | 1  |
|                  | 2                                   | 59             | 2  |
| +62 or –62       | 2                                   | 00 to 58       | 1  |
|                  | 2                                   | 59             | 3  |
| +63 or –63       | 2                                   | 00 to 58       | 1  |
|                  | 2                                   | 59             | 4  |
| –64              | 2                                   | 00 to 58       | 1  |
|                  | 2                                   | 59             | 5  |

[1] The correction pulses on pin  $\overline{\text{INT}}$  are  $\frac{1}{1024}$  s wide. For multiple pulses, they are repeated at an interval of  $\frac{1}{512}$  s.

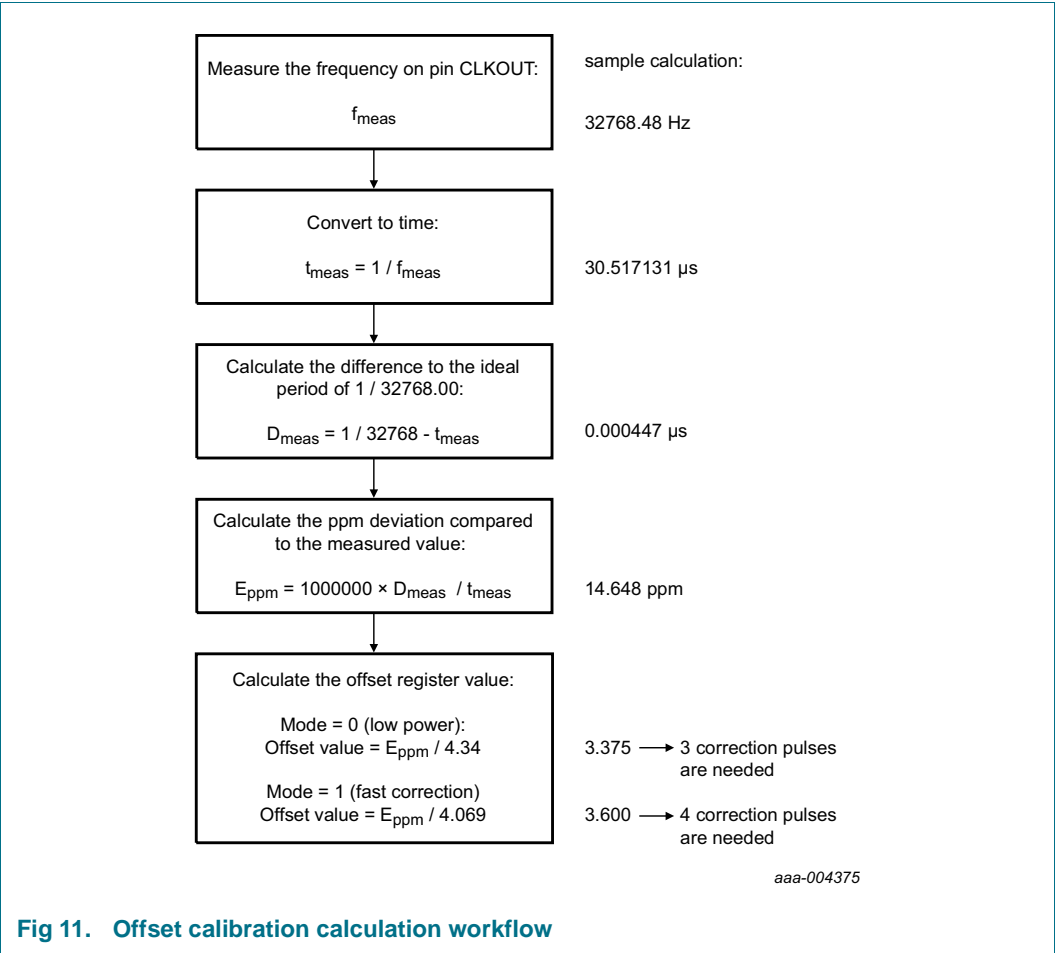
In MODE = 1, any timer source clock using a frequency below 1.024 kHz is also affected by the clock correction (see [Table 17](#)).

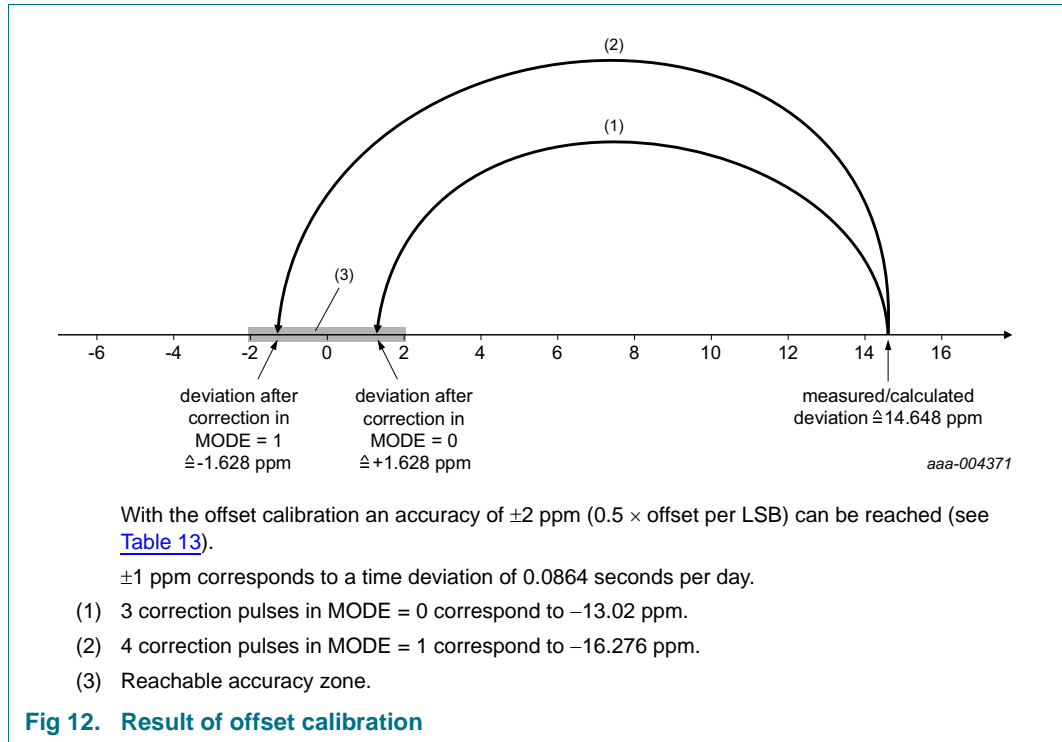
**Table 17. Effect of correction pulses on frequencies for MODE = 1**

| Frequency (Hz)            | Effect of correction |
|---------------------------|----------------------|
| <b>CLKOUT</b>             |                      |
| 32768                     | no effect            |
| 16384                     | no effect            |
| 8192                      | no effect            |
| 4096                      | no effect            |
| 2048                      | no effect            |
| 1024                      | no effect            |
| 1                         | affected             |
| <b>Timer source clock</b> |                      |
| 4096                      | no effect            |
| 64                        | affected             |
| 1                         | affected             |
| $\frac{1}{60}$            | affected             |

8.2.3.3 Offset calibration workflow

The calibration offset has to be calculated based on the time. [Figure 11](#) shows the workflow how the offset register values can be calculated:





### 8.2.4 Register RAM\_byte

The PCF85063A provides a free RAM byte, which can be used for any purpose, for example, status byte of the system.

**Table 18. RAM\_byte - 8-bit RAM register (address 03h) bit description**

| Bit    | Symbol | Value                               | Description |
|--------|--------|-------------------------------------|-------------|
| 7 to 0 | B[7:0] | 00000000 <sup>[1]</sup> to 11111111 | RAM content |

[1] Default value.

## 8.3 Time and date registers

Most of the registers are coded in the BCD format to simplify application use.

### 8.3.1 Register Seconds

**Table 19. Seconds - seconds register (address 04h) bit description**

| Bit    | Symbol  | Value                 | Place value | Description   |
|--------|---------|-----------------------|-------------|---|
| 7      | OS      |                       |             | <b>oscillator stop</b>  |
|        |         | 0                     | -           | clock integrity is guaranteed   |
|        |         | 1 <sup>[1]</sup>      | -           | clock integrity is not guaranteed; oscillator has stopped or has been interrupted |
| 6 to 4 | SECONDS | 0 <sup>[1]</sup> to 5 | ten's place | <b>actual seconds</b> coded in BCD format, see <a href="#">Table 20</a>           |
| 3 to 0 |         | 0 <sup>[1]</sup> to 9 | unit place  |   |

[1] Default value.

Table 20. Seconds coded in BCD format

| Seconds value in decimal | Upper-digit (ten's place) |       |       | Digit (unit place) |       |       |       |
|--------------------------|---------------------------|-------|-------|--------------------|-------|-------|-------|
|                          | Bit 6                     | Bit 5 | Bit 4 | Bit 3              | Bit 2 | Bit 1 | Bit 0 |
| 00 <sup>[1]</sup>        | 0                         | 0     | 0     | 0                  | 0     | 0     | 0     |
| 01                       | 0                         | 0     | 0     | 0                  | 0     | 0     | 1     |
| 02                       | 0                         | 0     | 0     | 0                  | 0     | 1     | 0     |
| :                        | :                         | :     | :     | :                  | :     | :     | :     |
| 09                       | 0                         | 0     | 0     | 1                  | 0     | 0     | 1     |
| 10                       | 0                         | 0     | 1     | 0                  | 0     | 0     | 0     |
| :                        | :                         | :     | :     | :                  | :     | :     | :     |
| 58                       | 1                         | 0     | 1     | 1                  | 0     | 0     | 0     |
| 59                       | 1                         | 0     | 1     | 1                  | 0     | 0     | 1     |

[1] Default value.

### 8.3.1.1 OS: Oscillator stop

When the oscillator of the PCF85063A is stopped, the OS flag is set. The oscillator can be stopped, for example, by connecting one of the oscillator pins OSC1 or OSC0 to ground. The oscillator is considered to be stopped during the time between power-on and stable crystal resonance. This time can be in the range of 200 ms to 2 s depending on crystal type, temperature, and supply voltage.

The flag remains set until cleared by command (see [Figure 13](#)). If the flag cannot be cleared, then the oscillator is not running. This method can be used to monitor the oscillator and to determine if the supply voltage has reduced to the point where oscillation fails.

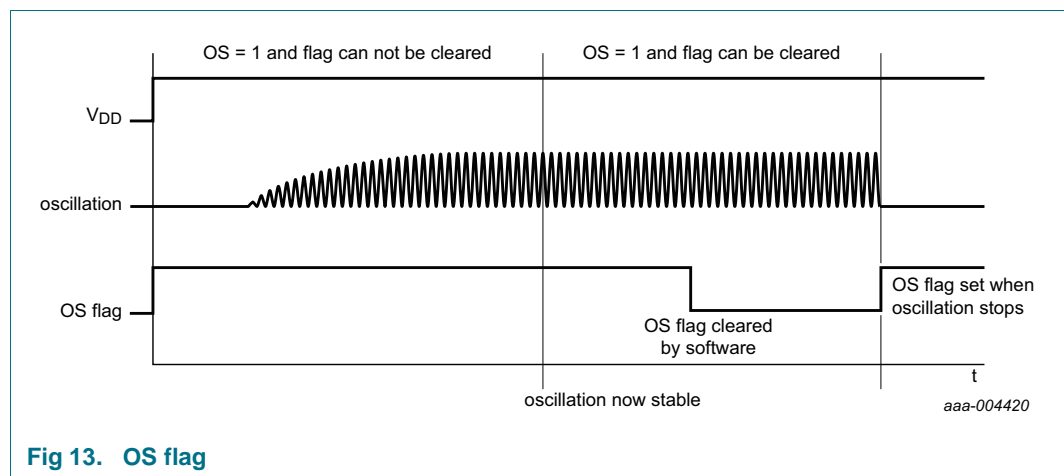


Fig 13. OS flag

### 8.3.2 Register Minutes

Table 21. Minutes - minutes register (address 05h) bit description

| Bit    | Symbol  | Value                 | Place value | Description                               |
|--------|---------|-----------------------|-------------|---|
| 7      | -       | 0                     | -           | unused                                    |
| 6 to 4 | MINUTES | 0 <sup>[1]</sup> to 5 | ten's place | <b>actual minutes</b> coded in BCD format |
| 3 to 0 |         | 0 <sup>[1]</sup> to 9 | unit place  |   |

[1] Default value.

### 8.3.3 Register Hours

Table 22. Hours - hours register (address 06h) bit description

| Bit                         | Symbol | Value                 | Place value | Description   |
|-----------------------------|--------|-----------------------|-------------|---|
| 7 to 6                      | -      | 00                    | -           | unused  |
| 12-hour mode <sup>[1]</sup> |        |                       |             |   |
| 5                           | AMPM   |                       |             | AM/PM indicator                                     |
|                             |        | 0 <sup>[2]</sup>      | -           | AM  |
|                             |        | 1                     | -           | PM  |
| 4                           | HOURS  | 0 <sup>[2]</sup> to 1 | ten's place | actual hours in 12-hour mode<br>coded in BCD format |
| 3 to 0                      |        | 0 <sup>[2]</sup> to 9 | unit place  |   |
| 24-hour mode <sup>[1]</sup> |        |                       |             |   |
| 5 to 4                      | HOURS  | 0 <sup>[2]</sup> to 2 | ten's place | actual hours in 24-hour mode<br>coded in BCD format |
| 3 to 0                      |        | 0 <sup>[2]</sup> to 9 | unit place  |   |

[1] Hour mode is set by the 12\_24 bit in register Control\_1.

[2] Default value.

### 8.3.4 Register Days

Table 23. Days - days register (address 07h) bit description

| Bit    | Symbol              | Value                 | Place value | Description                           |
|--------|---------------------|-----------------------|-------------|---------------------------------------|
| 7 to 6 | -                   | 00                    | -           | unused                                |
| 5 to 4 | DAYS <sup>[1]</sup> | 0 <sup>[2]</sup> to 3 | ten's place | <b>actual day</b> coded in BCD format |
| 3 to 0 |                     | 0 <sup>[3]</sup> to 9 | unit place  |                                       |

[1] If the year counter contains a value, which is exactly divisible by 4 (including the year 00), the PCF85063A compensates for leap years by adding a 29th day to February.

[2] Default value.

[3] Default value is 1.

### 8.3.5 Register Weekdays

Table 24. Weekdays - weekdays register (address 08h) bit description

| Bit    | Symbol   | Value  | Description  |
|--------|----------|--------|--|
| 7 to 3 | -        | 00000  | unused   |
| 2 to 0 | WEEKDAYS | 0 to 6 | <b>actual weekday</b> values, see <a href="#">Table 25</a> |

Table 25. Weekday assignments

| Day <sup>[1]</sup>      | Bit |   |   |
|-------------------------|-----|---|---|
|                         | 2   | 1 | 0 |
| Sunday                  | 0   | 0 | 0 |
| Monday                  | 0   | 0 | 1 |
| Tuesday                 | 0   | 1 | 0 |
| Wednesday               | 0   | 1 | 1 |
| Thursday                | 1   | 0 | 0 |
| Friday                  | 1   | 0 | 1 |
| Saturday <sup>[2]</sup> | 1   | 1 | 0 |

[1] Definition may be reassigned by the user.

[2] Default value.

### 8.3.6 Register Months

Table 26. Months - months register (address 09h) bit description

| Bit    | Symbol | Value  | Place value | Description   |
|--------|--------|--------|-------------|---|
| 7 to 5 | -      | 000    | -           | unused  |
| 4      | MONTHS | 0 to 1 | ten's place | <b>actual month</b> coded in BCD format, see <a href="#">Table 27</a> |
| 3 to 0 |        | 0 to 9 | unit place  |   |

Table 27. Month assignments in BCD format

| Month                  | Upper-digit<br>(ten's place) | Digit (unit place) |       |       |       |
|------------------------|------------------------------|--------------------|-------|-------|-------|
|                        | Bit 4                        | Bit 3              | Bit 2 | Bit 1 | Bit 0 |
| January <sup>[1]</sup> | 0                            | 0                  | 0     | 0     | 1     |
| February               | 0                            | 0                  | 0     | 1     | 0     |
| March                  | 0                            | 0                  | 0     | 1     | 1     |
| April                  | 0                            | 0                  | 1     | 0     | 0     |
| May                    | 0                            | 0                  | 1     | 0     | 1     |
| June                   | 0                            | 0                  | 1     | 1     | 0     |
| July                   | 0                            | 0                  | 1     | 1     | 1     |
| August                 | 0                            | 1                  | 0     | 0     | 0     |
| September              | 0                            | 1                  | 0     | 0     | 1     |
| October                | 1                            | 0                  | 0     | 0     | 0     |
| November               | 1                            | 0                  | 0     | 0     | 1     |
| December               | 1                            | 0                  | 0     | 1     | 0     |

[1] Default value.



### 8.3.7 Register Years

Table 28. Years - years register (0Ah) bit description

| Bit    | Symbol | Value     | Place value | Description                            |
|--------|--------|-----------|-------------|--|
| 7 to 4 | YEARS  | 0[1] to 9 | ten's place | <b>actual year</b> coded in BCD format |
| 3 to 0 |        | 0[1] to 9 | unit place  |  |

[1] Default value.

## 8.4 Setting and reading the time

Figure 14 shows the data flow and data dependencies starting from the 1 Hz clock tick.

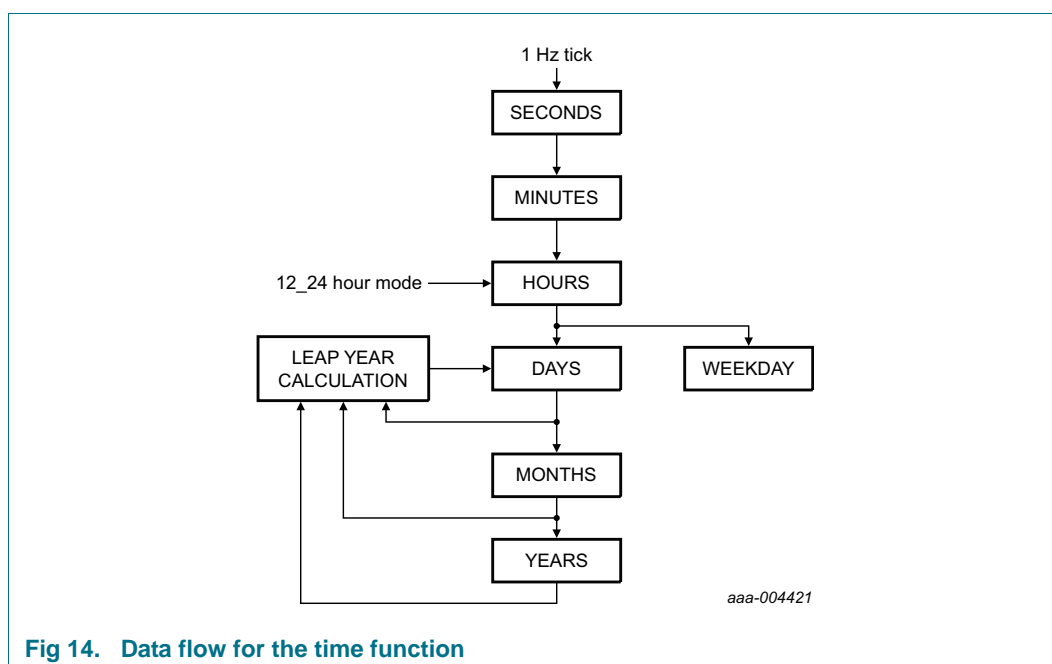


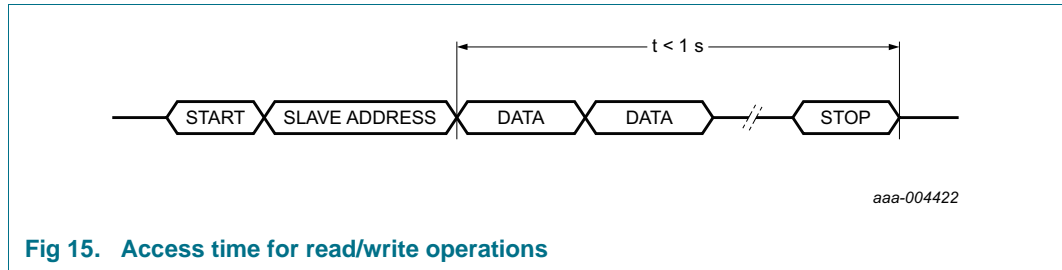
Fig 14. Data flow for the time function

During read/write operations, the time counting circuits (memory locations 04h through 0Ah) are blocked.

The blocking prevents

- Faulty reading of the clock and calendar during a carry condition
- Incrementing the time registers during the read cycle

After this read/write access is completed, the time circuit is released again and any pending request to increment the time counters that occurred during the read/write access is serviced. A maximum of 1 request can be stored; therefore, all accesses must be completed within 1 second (see Figure 15).



Because of this method, it is very important to make a read or write access in one go, that is, setting or reading seconds through to years should be made in one single access. Failing to comply with this method could result in the time becoming corrupted.

As an example, if the time (seconds through to hours) is set in one access and then in a second access the date is set, it is possible that the time will increment between the two accesses. A similar problem exists when reading. A roll-over may occur between reads thus giving the minutes from one moment and the hours from the next.

Recommended method for reading the time:

1. Send a START condition and the slave address (see [Table 39 on page 35](#)) for write (A2h)
2. Set the address pointer to 4 (Seconds) by sending 04h
3. Send a RESTART condition or STOP followed by START
4. Send the slave address for read (A3h)
5. Read Seconds
6. Read Minutes
7. Read Hours
8. Read Days
9. Read Weekdays
10. Read Months
11. Read Years
12. Send a STOP condition

## 8.5 Alarm registers

### 8.5.1 Register Second\_alarm

**Table 29. Second\_alarm - second alarm register (address 0Bh) bit description**

| Bit    | Symbol       | Value                 | Place value | Description  |
|--------|--------------|-----------------------|-------------|--|
| 7      | AEN_S        |                       |             | <b>second alarm</b>                                    |
|        |              | 0                     | -           | enabled  |
|        |              | 1 <sup>[1]</sup>      | -           | disabled   |
| 6 to 4 | SECOND_ALARM | 0 <sup>[1]</sup> to 5 | ten's place | <b>second alarm information</b><br>coded in BCD format |
| 3 to 0 |              | 0 <sup>[1]</sup> to 9 | unit place  |  |

[1] Default value.

### 8.5.2 Register Minute\_alarm

Table 30. Minute\_alarm - minute alarm register (address 0Ch) bit description

| Bit    | Symbol       | Value                 | Place value | Description   |
|--------|--------------|-----------------------|-------------|---|
| 7      | AEN_M        |                       |             | <b>minute alarm</b>                                 |
|        |              | 0                     | -           | enabled   |
|        |              | 1 <sup>[1]</sup>      | -           | disabled  |
| 6 to 4 | MINUTE_ALARM | 0 <sup>[1]</sup> to 5 | ten's place | <b>minute alarm information</b> coded in BCD format |
| 3 to 0 |              | 0 <sup>[1]</sup> to 9 | unit place  |   |

[1] Default value.

### 8.5.3 Register Hour\_alarm

Table 31. Hour\_alarm - hour alarm register (address 0Dh) bit description

| Bit                         | Symbol     | Value                 | Place value | Description   |
|-----------------------------|------------|-----------------------|-------------|---|
| 7                           | AEN_H      |                       |             | <b>hour alarm</b>   |
|                             |            | 0                     | -           | enabled   |
|                             |            | 1 <sup>[1]</sup>      | -           | disabled  |
| 6                           | -          | 0                     | -           | unused  |
| 12-hour mode <sup>[2]</sup> |            |                       |             |   |
| 5                           | AMPM       |                       |             | <b>AM/PM indicator</b>  |
|                             |            | 0 <sup>[1]</sup>      | -           | AM  |
|                             |            | 1                     | -           | PM  |
| 4                           | HOUR_ALARM | 0 <sup>[1]</sup> to 1 | ten's place | <b>hour alarm information in 12-hour mode</b> coded in BCD format |
| 3 to 0                      |            | 0 <sup>[1]</sup> to 9 | unit place  |   |
| 24-hour mode <sup>[2]</sup> |            |                       |             |   |
| 5 to 4                      | HOUR_ALARM | 0 <sup>[1]</sup> to 2 | ten's place | <b>hour alarm information in 24-hour mode</b> coded in BCD format |
| 3 to 0                      |            | 0 <sup>[1]</sup> to 9 | unit place  |   |

[1] Default value.

[2] Hour mode is set by the 12\_24 bit in register Control\_1.

### 8.5.4 Register Day\_alarm

Table 32. Day\_alarm - day alarm register (address 0Eh) bit description

| Bit    | Symbol    | Value                 | Place value | Description                                      |
|--------|-----------|-----------------------|-------------|--|
| 7      | AEN_D     |                       |             | <b>day alarm</b>                                 |
|        |           | 0                     | -           | enabled  |
|        |           | 1 <sup>[1]</sup>      | -           | disabled   |
| 6      | -         | 0                     | -           | unused   |
| 5 to 4 | DAY_ALARM | 0 <sup>[1]</sup> to 3 | ten's place | <b>day alarm information</b> coded in BCD format |
| 3 to 0 |           | 0 <sup>[1]</sup> to 9 | unit place  |  |

[1] Default value.

### 8.5.5 Register Weekday\_alarm

Table 33. Weekday\_alarm - weekday alarm register (address 0Fh) bit description

| Bit    | Symbol        | Value                 | Description  |
|--------|---------------|-----------------------|--|
| 7      | AEN_W         |                       | <b>weekday alarm</b>                                 |
|        |               | 0                     | enabled  |
|        |               | 1 <sup>[1]</sup>      | disabled   |
| 6 to 3 | -             | 0                     | unused   |
| 2 to 0 | WEEKDAY_ALARM | 0 <sup>[1]</sup> to 6 | <b>weekday alarm information</b> coded in BCD format |

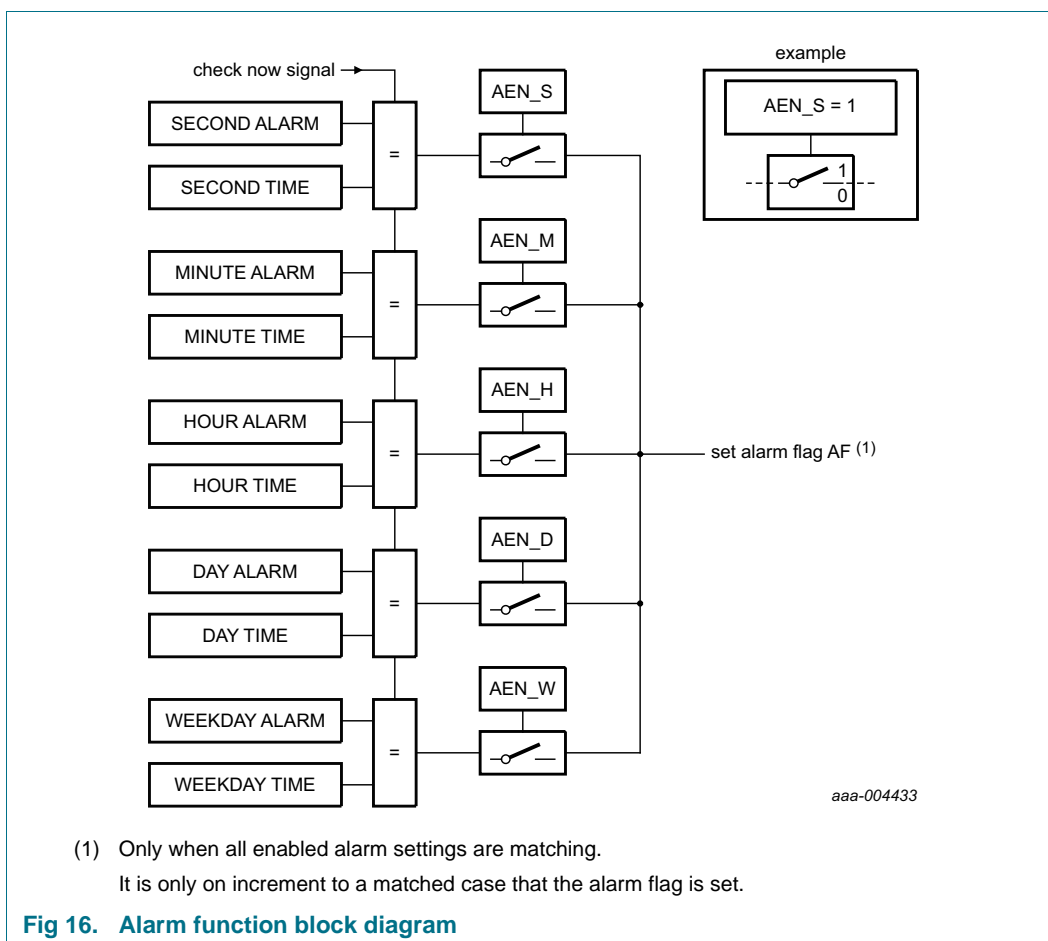
[1] Default value.

### 8.5.6 Alarm function

By clearing the alarm enable bit (AEN\_x) of one or more of the alarm registers, the corresponding alarm condition(s) are active. When an alarm occurs, AF is set logic 1. The asserted AF can be used to generate an interrupt ( $\overline{\text{INT}}$ ). The AF is cleared by command.

The registers at addresses 0Bh through 0Fh contain alarm information. When one or more of these registers is loaded with second, minute, hour, day or weekday, and its corresponding AEN\_x is logic 0, then that information is compared with the current second, minute, hour, day, and weekday. When all enabled comparisons first match, the alarm flag (AF in register Control\_2) is set logic 1.

The generation of interrupts from the alarm function is controlled via bit AIE. If bit AIE is enabled, the  $\overline{\text{INT}}$  pin follows the condition of bit AF. AF remains set until cleared by command. Once AF has been cleared, it will only be set again when the time increments to match the alarm condition once more. Alarm registers which have their AEN\_x bit at logic 1 are ignored.



## 8.6 Timer registers

The 8-bit countdown timer at address 10h is controlled by the register Timer\_mode at address 11h.

### 8.6.1 Register Timer\_value

**Table 34. Timer\_value - timer value register (address 10h) bit description**

| Bit    | Symbol | Value                    | Description                          |
|--------|--------|--------------------------|--------------------------------------|
| 7 to 0 | T[7:0] | 0h <sup>[1]</sup> to FFh | countdown timer value <sup>[2]</sup> |

[1] Default value.

[2] Countdown period in seconds:  $CountdownPeriod = \frac{T}{SourceClockFrequency}$  where T is the countdown value.

### 8.6.2 Register Timer\_mode

Table 35. Timer\_mode - timer control register (address 11h) bit description

| Bit    | Symbol               | Value             | Description                          |
|--------|----------------------|-------------------|--------------------------------------|
| 7 to 5 | -                    | 000               | unused                               |
| 4 to 3 | TCF[1:0]             |                   | <b>timer clock frequency</b>         |
|        |                      | 00                | 4.096 kHz timer source clock         |
|        |                      | 01                | 64 Hz timer source clock             |
|        |                      | 10                | 1 Hz timer source clock              |
|        |                      | 11 <sup>[1]</sup> | $\frac{1}{60}$ Hz timer source clock |
| 2      | TE                   |                   | <b>timer enable</b>                  |
|        |                      | 0 <sup>[1]</sup>  | timer is disabled                    |
|        |                      | 1                 | timer is enabled                     |
| 1      | TIE                  |                   | <b>timer interrupt enable</b>        |
|        |                      | 0 <sup>[1]</sup>  | no interrupt generated from timer    |
|        |                      | 1                 | interrupt generated from timer       |
| 0      | TI_TP <sup>[2]</sup> |                   | <b>timer interrupt mode</b>          |
|        |                      | 0 <sup>[1]</sup>  | interrupt follows timer flag         |
|        |                      | 1                 | interrupt generates a pulse          |

[1] Default value.

[2] How the setting of TI\_TP and the timer flag TF can affect the  $\overline{\text{INT}}$  pulse generation is explained in [Section 8.2.2.3 on page 15](#).

### 8.6.3 Timer functions

The timer has four selectable source clocks allowing for countdown periods in the range from 244  $\mu\text{s}$  to 4 hours 15 min. For periods longer than 4 hours, the alarm function can be used.

Table 36. Timer clock frequency and timer durations

| TCF[1:0] | Timer source clock frequency <sup>[1]</sup> | Delay                           |                                   |
|----------|---|---------------------------------|-----------------------------------|
|          |   | Minimum timer duration<br>T = 1 | Maximum timer duration<br>T = 255 |
| 00       | 4.096 kHz                                   | 244 $\mu\text{s}$               | 62.256 ms                         |
| 01       | 64 Hz                                       | 15.625 ms                       | 3.984 s                           |
| 10       | 1 Hz <sup>[2]</sup>                         | 1 s                             | 255 s                             |
| 11       | $\frac{1}{60}$ Hz <sup>[2]</sup>            | 60 s                            | 4 hours 15 min                    |

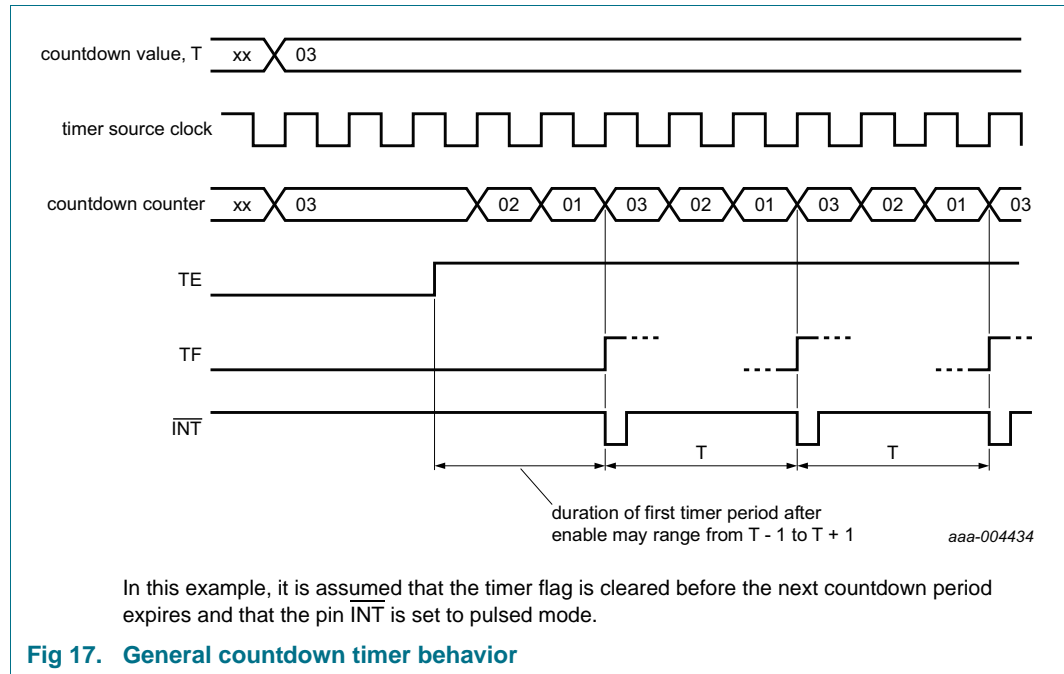
[1] When not in use, TCF[1:0] must be set to  $\frac{1}{60}$  Hz for power saving.

[2] Time periods can be affected by correction pulses.

**Remark:** Note that all timings which are generated from the 32.768 kHz oscillator are based on the assumption that there is 0 ppm deviation. Deviation in oscillator frequency results in deviation in timings. This is not applicable to interface timing.

The timer counts down from a software-loaded 8-bit binary value, T[7:0], in register Timer\_value. Loading the counter with 0 stops the timer. Values from 1 to 255 are valid.

When the counter decrements from 1, the timer flag (bit TF in register Control\_2) is set and the counter automatically re-loads and starts the next timer period.



**Fig 17. General countdown timer behavior**

If a new value of T is written before the end of the current timer period, then this value takes immediate effect. NXP does not recommend changing T without first disabling the counter by setting bit TE logic 0. The update of T is asynchronous to the timer clock. Therefore changing it without setting bit TE logic 0 may result in a corrupted value loaded into the countdown counter. This results in an undetermined countdown period for the first period. The countdown value T will, however, be correctly stored and correctly loaded on subsequent timer periods.

When the TIE flag is set, an interrupt signal on INT is generated if this mode is enabled. See [Section 8.2.2](#) for details on how the interrupt can be controlled.

When starting the timer for the first time, the first period has an uncertainty. The uncertainty is a result of the enable instruction being generated from the interface clock which is asynchronous from the timer source clock. Subsequent timer periods do not have such delay. The amount of delay for the first timer period depends on the chosen source clock, see [Table 37](#).

**Table 37. First period delay for timer counter value T**

| Timer source clock        | Minimum timer period                | Maximum timer period          |
|---------------------------|-------------------------------------|-------------------------------|
| 4.096 kHz                 | T                                   | T + 1                         |
| 64 Hz                     | T                                   | T + 1                         |
| 1 Hz                      | $(T - 1) + \frac{1}{64 \text{ Hz}}$ | $T + \frac{1}{64 \text{ Hz}}$ |
| $\frac{1}{60} \text{ Hz}$ | $(T - 1) + \frac{1}{64 \text{ Hz}}$ | $T + \frac{1}{64 \text{ Hz}}$ |

At the end of every countdown, the timer sets the countdown timer flag (bit TF in register Control\_2). Bit TF can only be cleared by command. The asserted bit TF can be used to generate an interrupt at pin INT. The interrupt may be generated as a pulsed signal every countdown period or as a permanently active signal which follows the condition of bit TF. Bit TI\_TP is used to control this mode selection and the interrupt output may be disabled with bit TIE, see [Table 35](#) and [Figure 17](#).

When reading the timer, the current countdown value is returned and **not** the initial value T. Since it is not possible to freeze the countdown timer counter during read back, it is recommended to read the register twice and check for consistent results.

Timer source clock frequency selection of 1 Hz and 1/60 Hz is affected by the Offset register. The duration of a program period varies according to when the offset is initiated. For example, if a 100 s timer is set using the 1 Hz clock as source, then some 100 s periods will contain correction pulses and therefore be longer or shorter depending on the setting of the Offset register. See [Section 8.2.3](#) to understand the operation of the Offset register.

### 8.6.3.1 Countdown timer interrupts

The pulse generator for the countdown timer interrupt uses an internal clock and is dependent on the selected source clock for the countdown timer and on the countdown value T. As a consequence, the width of the interrupt pulse varies (see [Table 38](#)).

**Table 38.**  $\overline{\text{INT}}$  operation

*TF and  $\overline{\text{INT}}$  become active simultaneously.*

| Source clock (Hz) | INT period (s)       |                      |
|-------------------|----------------------|----------------------|
|                   | T = 1 <sup>[1]</sup> | T > 1 <sup>[1]</sup> |
| 4096              | 1/8192               | 1/4096               |
| 64                | 1/128                | 1/64                 |
| 1                 | 1/64                 | 1/64                 |
| 1/60              | 1/64                 | 1/64                 |

[1] T = loaded countdown value. Timer stops when T = 0.



## 9. Characteristics of the I<sup>2</sup>C-bus interface

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial CLock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

### 9.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse, as changes in the data line at this time are interpreted as a control signal (see [Figure 18](#)).

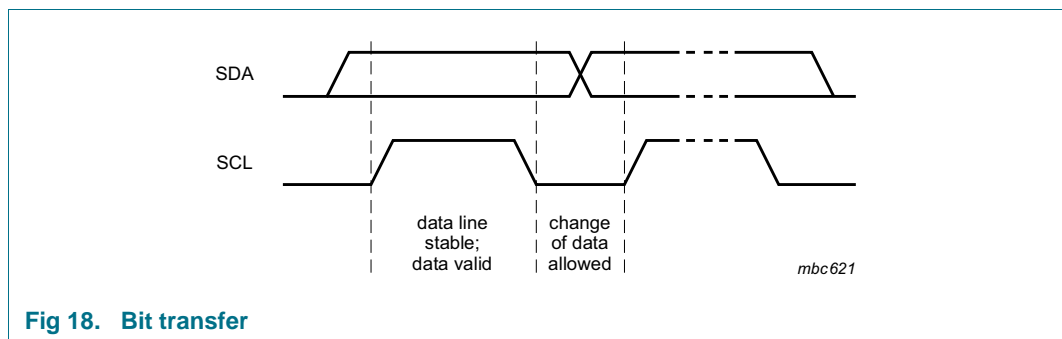


Fig 18. Bit transfer

### 9.2 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy.

A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition - S.

A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition - P (see [Figure 19](#)).

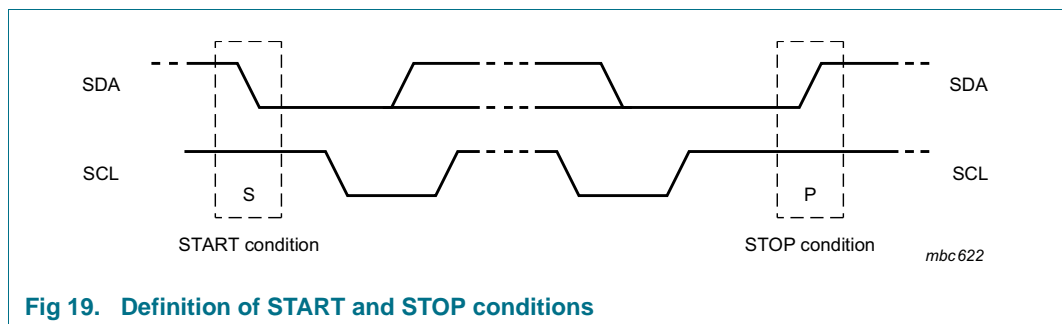
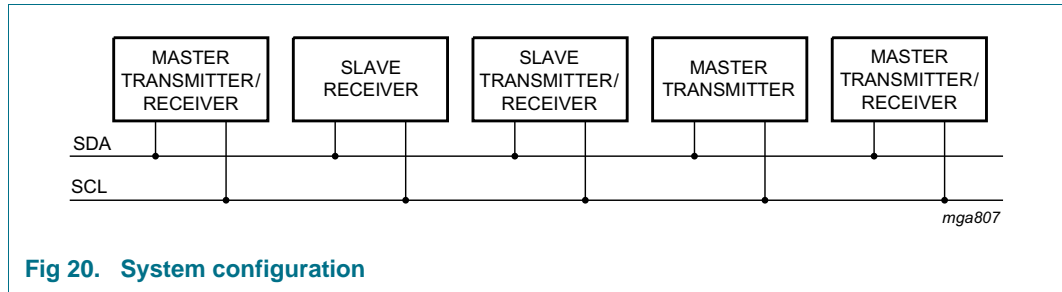


Fig 19. Definition of START and STOP conditions

### 9.3 System configuration

A device generating a message is a transmitter; a device receiving a message is a receiver. The device that controls the message is the master; and the devices which are controlled by the master are the slaves (see [Figure 20](#)).

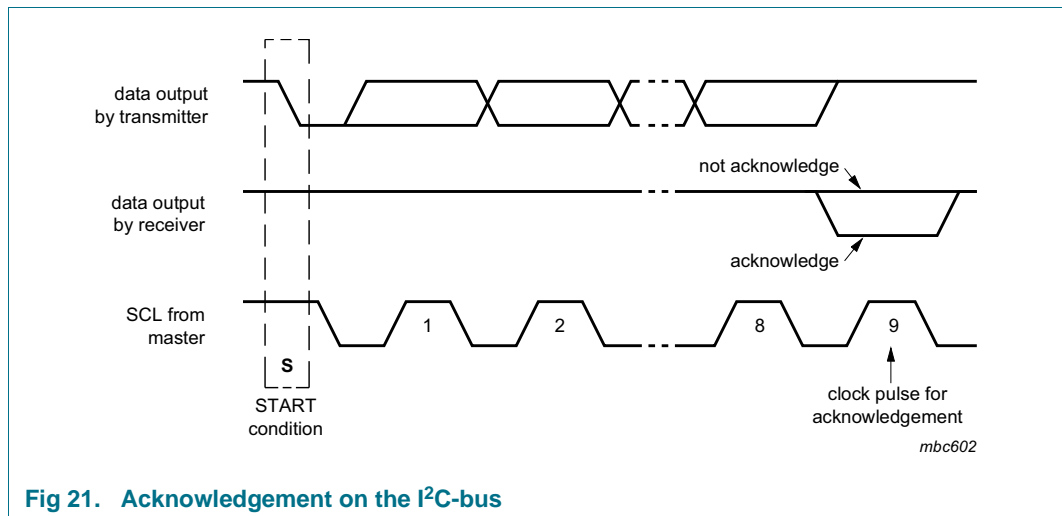


## 9.4 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of 8 bits is followed by an acknowledge cycle.

- A slave receiver, which is addressed, must generate an acknowledge after the reception of each byte
- Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter
- The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be considered)
- A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition

Acknowledgement on the I<sup>2</sup>C-bus is shown in [Figure 21](#).



## 9.5 I<sup>2</sup>C-bus protocol

### 9.5.1 Addressing

One I<sup>2</sup>C-bus slave address (1010001) is reserved for the PCF85063A. The entire I<sup>2</sup>C-bus slave address byte is shown in [Table 39](#).

**Table 39. I<sup>2</sup>C slave address byte**

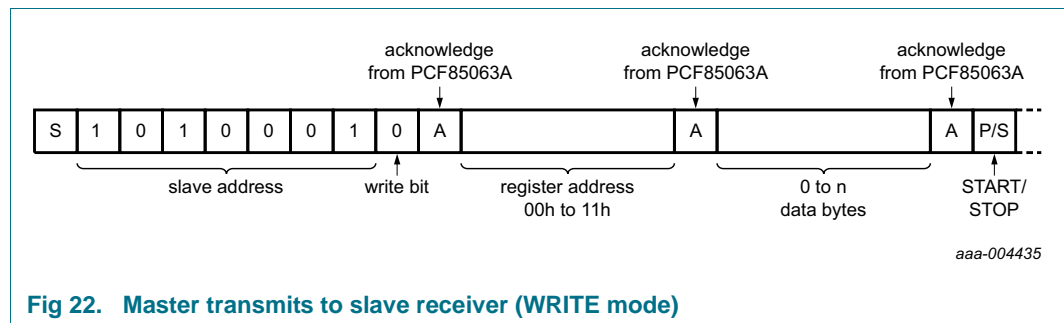
| Bit | Slave address |   |   |   |   |   |   |     |
|-----|---------------|---|---|---|---|---|---|-----|
|     | 7             | 6 | 5 | 4 | 3 | 2 | 1 | 0   |
|     | MSB           |   |   |   |   |   |   | LSB |
|     | 1             | 0 | 1 | 0 | 0 | 0 | 1 | R/W |

After a START condition, the I<sup>2</sup>C slave address has to be sent to the PCF85063A device.

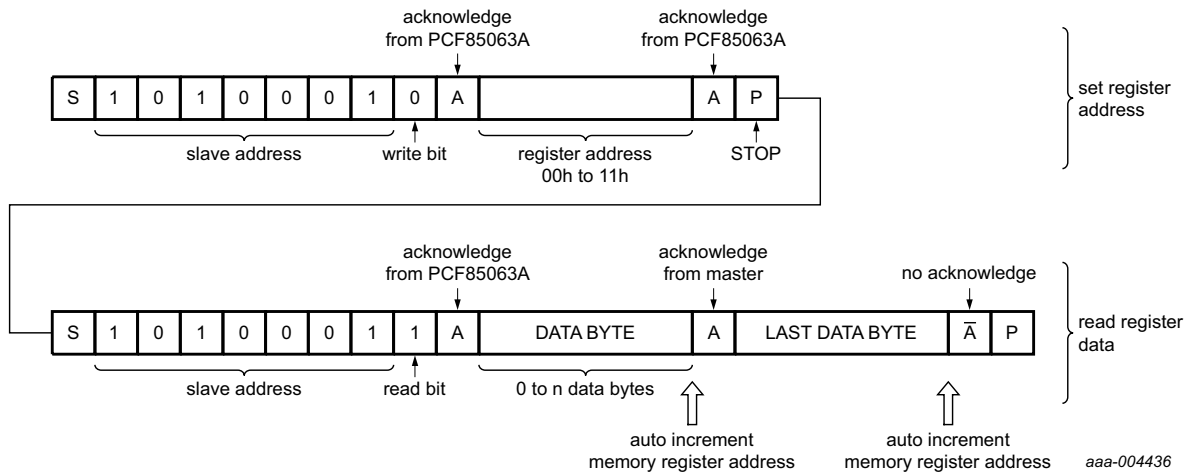
The R/W bit defines the direction of the following single or multiple byte data transfer (R/W = 0 for writing, R/W = 1 for reading). For the format and the timing of the START condition (S), the STOP condition (P) and the acknowledge bit (A) refer to the I<sup>2</sup>C-bus characteristics (see [Ref. 16 "UM10204"](#)). In the write mode, a data transfer is terminated by sending either the STOP condition or the START condition of the next data transfer.

### 9.5.2 Clock and calendar READ or WRITE cycles

The I<sup>2</sup>C-bus configuration for the different PCF85063A READ and WRITE cycles is shown in [Figure 22](#) and [Figure 23](#). The register address is a 5-bit value that defines which register is to be accessed next. The upper 3 bits of the register address are not used.



**Fig 22. Master transmits to slave receiver (WRITE mode)**



For multimaster configurations and to fasten the communication, the STOP-START sequence can be replaced by a repeated START (Sr).

**Fig 23. Master reads after setting register address (write register address; READ data)**

#### 9.5.2.1 I<sup>2</sup>C-bus error recovery technique

Slave devices like the PCF85063A use a state machine to implement the I<sup>2</sup>C protocol and expect a certain sequence of events to occur to function properly. Unexpected events at the I<sup>2</sup>C master can wreak havoc with the slaves connected on the bus. However, it is usually possible to recover deterministically to a known bus state with careful protocol manipulation.

A deterministic method to clear this situation if SDA is stuck LOW (it effectively blocks any other I<sup>2</sup>C-bus transaction, once the master recognizes a 'stuck bus' state), is for the master to blindly transmit nine clocks on SCL. If the slave was transmitting data or acknowledging, nine or more clocks ensures the slave state machine returns to a known, idle state since the protocol calls for eight data bits and one ACK bit. It does not matter when the slave state machine finishes its transmission; extra clocks are recognized as STOP conditions.

With careful design of the bus master error recovery firmware, many I<sup>2</sup>C-bus protocol problems can be avoided.

S/W considerations: NXP recommends customers allow for S/W reset capability to enable the bus error recovery technique. The 9-clock pulse method as described above involves a bus-master capable of providing such a signal.

Further comments/additional information are available in [Ref. 17 "UM10301"](#) and [Ref. 16 "UM10204"](#).

## 10. Internal circuitry

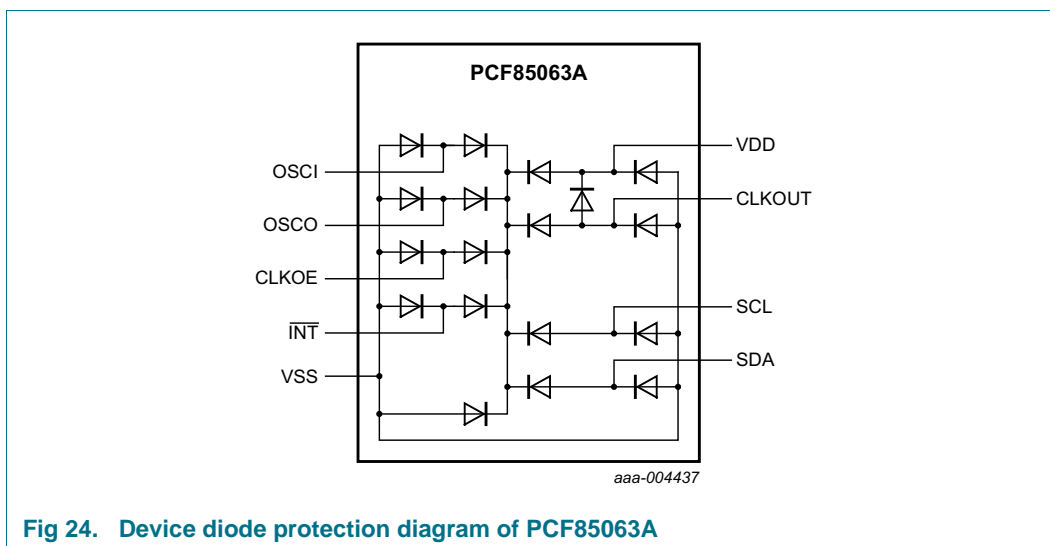


Fig 24. Device diode protection diagram of PCF85063A

## 11. Safety notes

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 12. Limiting values

**Table 40. Limiting values<sup>[1]</sup>**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol           | Parameter                       | Conditions                    | Min  | Max   | Unit |
|------------------|---------------------------------|-------------------------------|------|-------|------|
| V <sub>DD</sub>  | supply voltage                  |                               | −0.5 | +6.5  | V    |
| I <sub>DD</sub>  | supply current                  |                               | −50  | +50   | mA   |
| V <sub>I</sub>   | input voltage                   | on pins SCL, SDA, OSCI, CLKOE | −0.5 | +6.5  | V    |
| V <sub>O</sub>   | output voltage                  |                               | −0.5 | +6.5  | V    |
| I <sub>I</sub>   | input current                   | at any input                  | −10  | +10   | mA   |
| I <sub>O</sub>   | output current                  | at any output                 | −10  | +10   | mA   |
| P <sub>tot</sub> | total power dissipation         |                               | -    | 300   | mW   |
| V <sub>ESD</sub> | electrostatic discharge voltage | HBM <sup>[2]</sup>            | -    | ±5000 | V    |
|                  |                                 | CDM <sup>[3]</sup>            |      |       |      |
|                  |                                 | PCF85063ATL                   | -    | ±1750 | V    |
|                  |                                 | PCF85063AT                    | -    | ±2000 | V    |
|                  |                                 | PCF85063ATT                   | -    | ±2000 | V    |
| I <sub>Iu</sub>  | latch-up current                | <sup>[4]</sup>                | -    | 200   | mA   |
| T <sub>stg</sub> | storage temperature             | <sup>[5]</sup>                | −65  | +150  | °C   |
| T <sub>amb</sub> | ambient temperature             | operating device              | −40  | +85   | °C   |

[1] Remark: The PCF85063A part is not guaranteed (nor characterized) above the operating range as denoted in the datasheet. NXP recommends not to bias the PCF85063A device during reflow (e.g. if utilizing a 'coin' type battery in the assembly). If customer so chooses to continue to use this assembly method, there must be the allowance for a full '0 V' level Power supply 'reset' to re-enable the device. Without a proper POR, the device may remain in an indeterminate state.

[2] Pass level; Human Body Model (HBM) according to [Ref. 7 "JESD22-A114"](#).

[3] Pass level; Charged-Device Model (CDM), according to [Ref. 8 "JESD22-C101"](#).

[4] Pass level; latch-up testing, according to [Ref. 9 "JESD78"](#) at maximum ambient temperature (T<sub>amb(max)</sub>).

[5] According to the store and transport requirements (see [Ref. 18 "UM10569"](#)) the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

### 13. Characteristics

**Table 41. Static characteristics**

$V_{DD} = 0.9\text{ V}$  to  $5.5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768\text{ kHz}$ ; quartz  $R_s = 60\text{ k}\Omega$ ;  $C_L = 7\text{ pF}$ ; unless otherwise specified.

| Symbol                     | Parameter                 | Conditions  | Min                | Typ | Max                 | Unit |
|----------------------------|---------------------------|---|--------------------|-----|---------------------|------|
| Supplies                   |                           |   |                    |     |                     |      |
| V <sub>DD</sub>            | supply voltage            | interface inactive; <a href="#">[1]</a><br>f <sub>SCL</sub> = 0 Hz                              | 0.9                | -   | 5.5                 | V    |
|                            |                           | interface active; <a href="#">[2]</a><br>f <sub>SCL</sub> = 400 kHz                             | 1.8                | -   | 5.5                 | V    |
| I <sub>DD</sub>            | supply current            | CLKOUT disabled; <a href="#">[3]</a><br>V <sub>DD</sub> = 3.3 V                                 |                    |     |                     |      |
|                            |                           | interface inactive;<br>f <sub>SCL</sub> = 0 Hz  |                    |     |                     |      |
|                            |                           | T <sub>amb</sub> = 25 °C  | -                  | 220 | 450                 | nA   |
|                            |                           | T <sub>amb</sub> = 50 °C <a href="#">[4]</a>  | -                  | 250 | 500                 | nA   |
|                            |                           | T <sub>amb</sub> = 85 °C  | -                  | 470 | 600                 | nA   |
|                            |                           | interface active;<br>f <sub>SCL</sub> = 400 kHz   | -                  | 18  | 50                  | μA   |
| Inputs <a href="#">[5]</a> |                           |   |                    |     |                     |      |
| V <sub>I</sub>             | input voltage             |   | −0.5               | -   | +5.5                | V    |
| V <sub>IL</sub>            | LOW-level input voltage   |   | −0.5               | -   | +0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>            | HIGH-level input voltage  |   | 0.7V <sub>DD</sub> | -   | 5.5                 | V    |
| I <sub>LI</sub>            | input leakage current     | V <sub>I</sub> = V <sub>SS</sub> or V <sub>DD</sub>   | -                  | 0   | -                   | μA   |
|                            |                           | post ESD event  | −0.15              | -   | +0.15               | μA   |
| C <sub>i</sub>             | input capacitance         | <a href="#">[6]</a>   | -                  | -   | 7                   | pF   |
| Outputs                    |                           |   |                    |     |                     |      |
| V <sub>OH</sub>            | HIGH-level output voltage | on pin CLKOUT   | 0.8V <sub>DD</sub> | -   | V <sub>DD</sub>     | V    |
| V <sub>OL</sub>            | LOW-level output voltage  | on pins SDA, $\overline{\text{INT}}$ ,<br>CLKOUT  | V <sub>SS</sub>    | -   | 0.2V <sub>DD</sub>  | V    |
| I <sub>OH</sub>            | HIGH-level output current | output source current;<br>V <sub>OH</sub> = 2.9 V;<br>V <sub>DD</sub> = 3.3 V;<br>on pin CLKOUT | 1                  | 3   | -                   | mA   |
| I <sub>OL</sub>            | LOW-level output current  | output sink current;<br>V <sub>OL</sub> = 0.4 V;<br>V <sub>DD</sub> = 3.3 V                     |                    |     |                     |      |
|                            |                           | on pin SDA  | 3                  | 8.5 | -                   | mA   |
|                            |                           | on pin $\overline{\text{INT}}$  | 2                  | 6   | -                   | mA   |
|                            |                           | on pin CLKOUT   | 1                  | 3   | -                   | mA   |

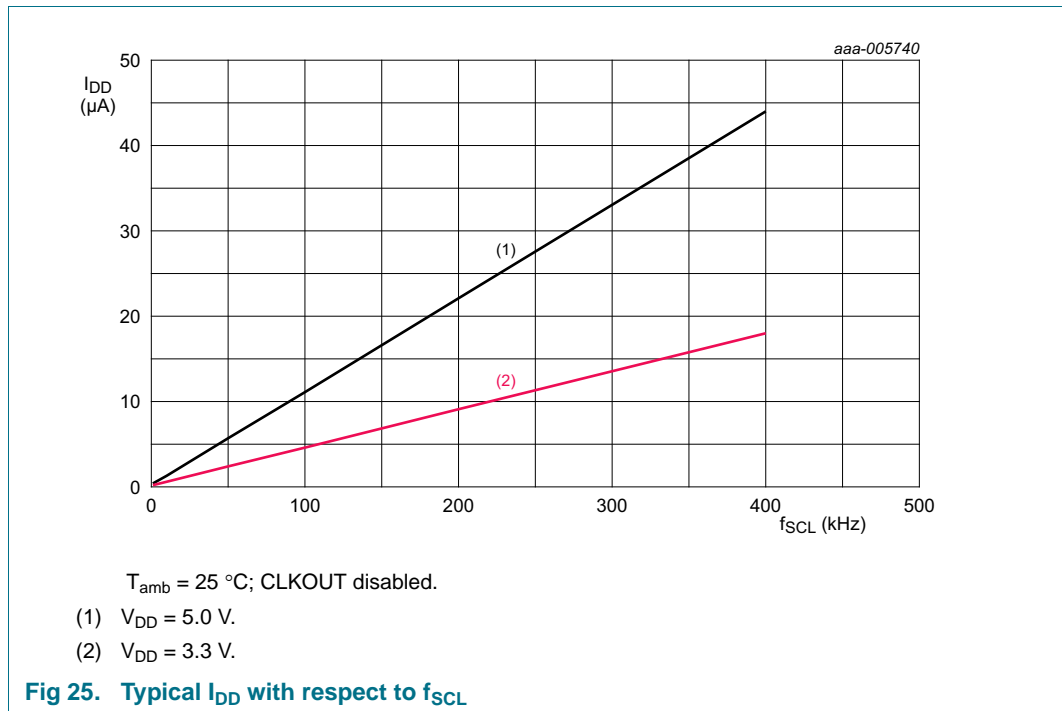
**Table 41. Static characteristics ...continued**

$V_{DD} = 0.9 \text{ V to } 5.5 \text{ V}$ ;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ }^{\circ}\text{C to } +85 \text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768 \text{ kHz}$ ; quartz  $R_s = 60 \text{ k}\Omega$ ;  $C_L = 7 \text{ pF}$ ; unless otherwise specified.

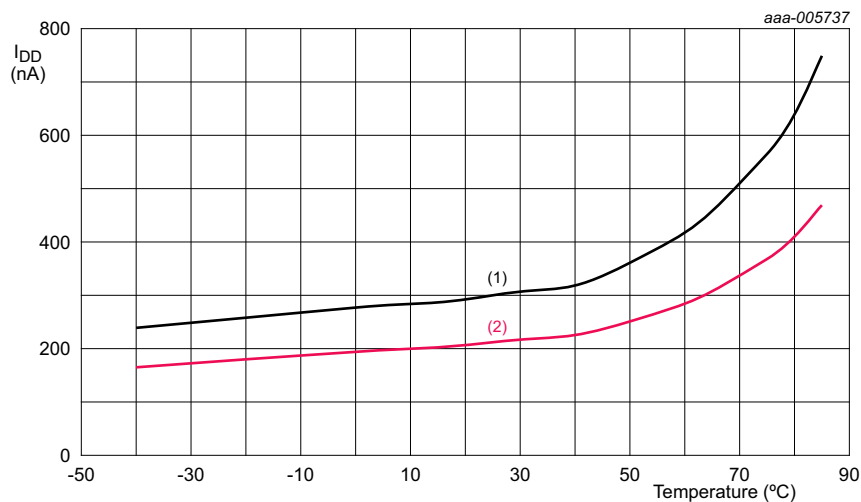
| Symbol                   | Parameter                               | Conditions  | Min | Typ   | Max  | Unit       |
|--------------------------|---|---|-----|-------|------|------------|
| <b>Oscillator</b>        |   |   |     |       |      |            |
| $\Delta f_{osc}/f_{osc}$ | relative oscillator frequency variation | $\Delta V_{DD} = 200 \text{ mV}$ ;<br>$T_{amb} = 25 \text{ }^{\circ}\text{C}$ | -   | 0.075 | -    | ppm        |
| $C_{L(itg)}$             | integrated load capacitance             | on pins OSC0, OSC1 [7]  |     |       |      |            |
|                          |   | $C_L = 7 \text{ pF}$  | 4.2 | 7     | 9.8  | pF         |
|                          |   | $C_L = 12.5 \text{ pF}$   | 7.5 | 12.5  | 17.5 | pF         |
| $R_s$                    | series resistance                       |   | -   | -     | 100  | k $\Omega$ |

- [1] For reliable oscillator start-up at power-on use  $V_{DD}$  greater than 1.2 V. If powered up at 0.9 V the oscillator will start but it might be a bit slow, especially if at high temperature. Normally the power supply is not 0.9 V at start-up and only comes at the end of battery discharge.  $V_{DD}$  min of 0.9 V is specified so that the customer can calculate how large a battery or capacitor they need for their application.  $V_{DD}$  min of 1.2 V or greater is needed to ensure speedy oscillator start-up time. For a restart condition, NXP recommends a full '0 V'  $V_{DD}$  value upon re-biasing.
- [2] 400 kHz I2C operation is production tested at 1.8 V. Design methodology allows I2C operation at 1.8 V – 5 % (1.71 V) which has been verified during product characterization on a limited number of devices.
- [3] Timer source clock =  $\frac{1}{60}$  Hz, level of pins SCL and SDA is  $V_{DD}$  or  $V_{SS}$ .
- [4] Tested on sample basis.
- [5] The I<sup>2</sup>C-bus interface of PCF85063A is 5 V tolerant.
- [6] Implicit by design.

- [7] Integrated load capacitance,  $C_{L(itg)}$ , is a calculation of  $C_{OSCI}$  and  $C_{OSCO}$  in series:  $C_{L(itg)} = \frac{(C_{OSCI} \cdot C_{OSCO})}{(C_{OSCI} + C_{OSCO})}$ .



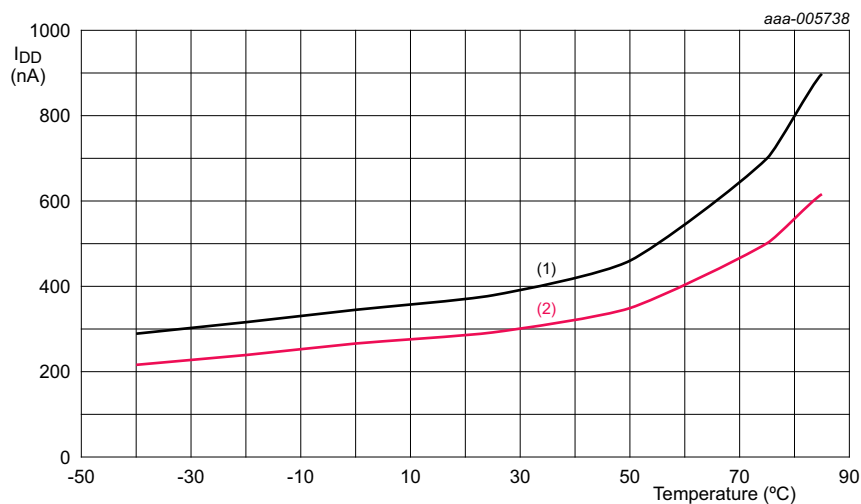




$C_{L(itg)} = 7 \text{ pF}$ ; CLKOUT disabled.

(1)  $V_{DD} = 5.5 \text{ V}$ .

(2)  $V_{DD} = 3.3 \text{ V}$ .

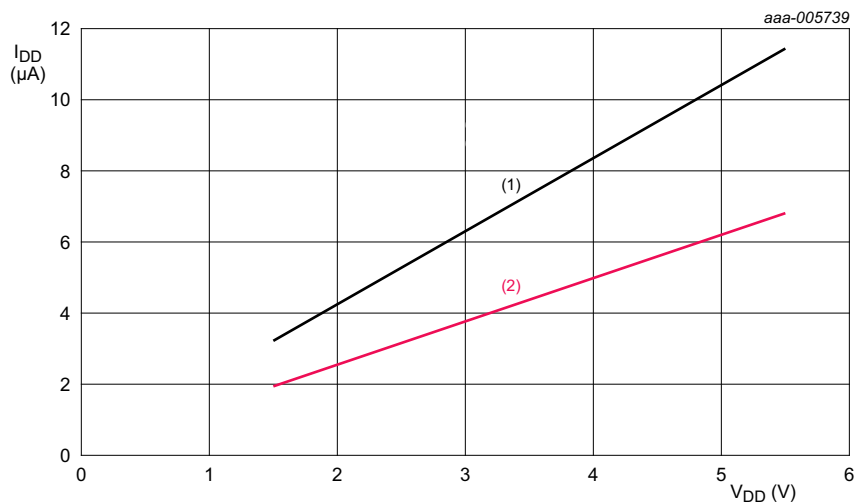


$C_{L(itg)} = 12.5 \text{ pF}$ ; CLKOUT disabled.

(1)  $V_{DD} = 5.5 \text{ V}$ .

(2)  $V_{DD} = 3.3 \text{ V}$ .

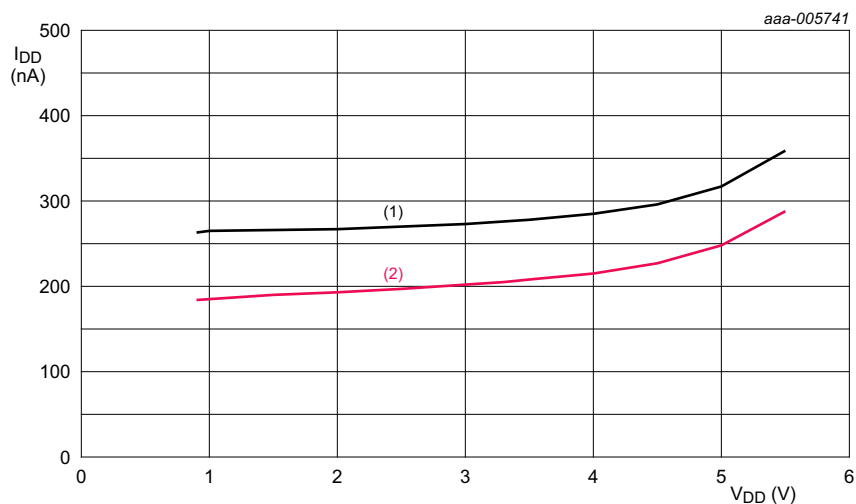
**Fig 26. Typical  $I_{DD}$  as a function of temperature**



$T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $f_{CLKOUT} = 32768\text{ Hz}$ .

(1) 47 pF CLKOUT load.

(2) 22 pF CLKOUT load.

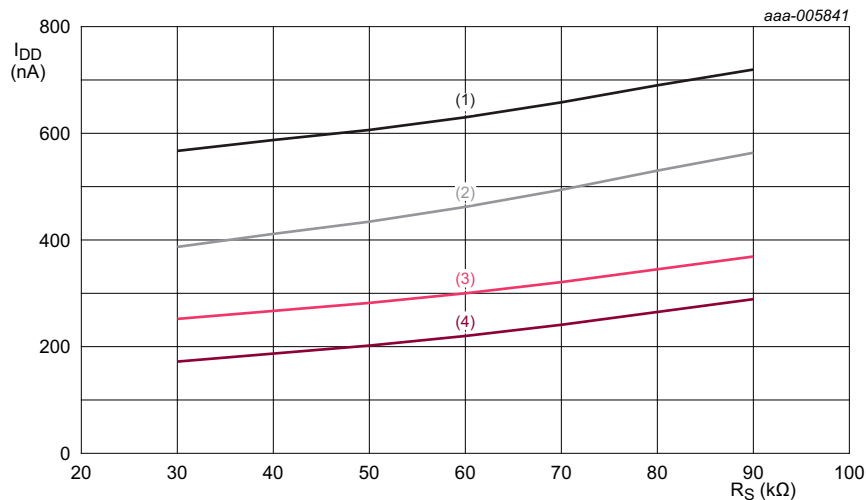


$T_{amb} = 25\text{ }^{\circ}\text{C}$ ; CLKOUT disabled.

(1)  $C_{L(itg)} = 12.5\text{ pF}$ .

(2)  $C_{L(itg)} = 7\text{ pF}$ .

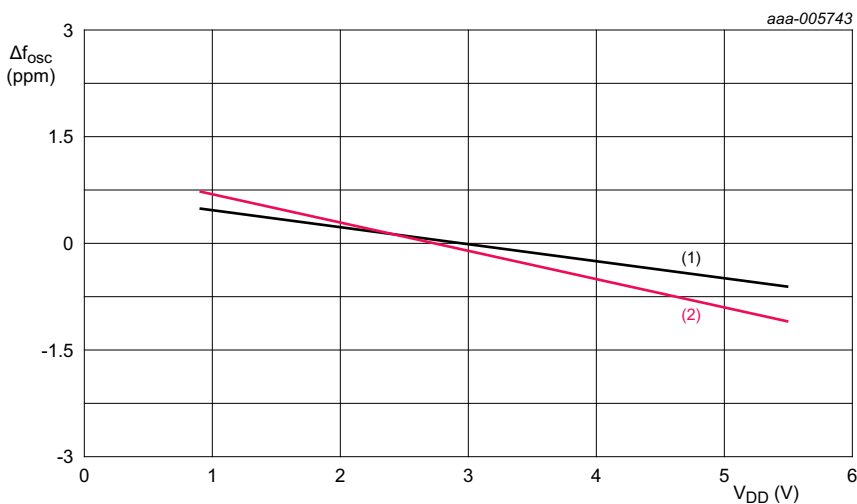
**Fig 27. Typical  $I_{DD}$  with respect to  $V_{DD}$**



$V_{DD} = 3.3$  V; CLKOUT disabled.

- (1)  $C_{L(itg)} = 12.5$  pF; 50 °C; maximum value.
- (2)  $C_{L(itg)} = 7$  pF; 50 °C; maximum value.
- (3)  $C_{L(itg)} = 12.5$  pF; 25 °C; typical value.
- (4)  $C_{L(itg)} = 7$  pF; 25 °C; typical value.

**Fig 28.**  $I_{DD}$  with respect to quartz  $R_S$



$T_{amb} = 25$  °C.

- (1)  $C_{L(itg)} = 7$  pF.
- (2)  $C_{L(itg)} = 12.5$  pF.

**Fig 29.** Oscillator frequency variation with respect to  $V_{DD}$

**Table 42. I<sup>2</sup>C-bus characteristics**

$V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}$ ;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ }^{\circ}\text{C to } +85 \text{ }^{\circ}\text{C}$ ;  $f_{osc} = 32.768 \text{ kHz}$ ; quartz  $R_s = 60 \text{ k}\Omega$ ;  $C_L = 7 \text{ pF}$ ; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ <sup>[1]</sup>.

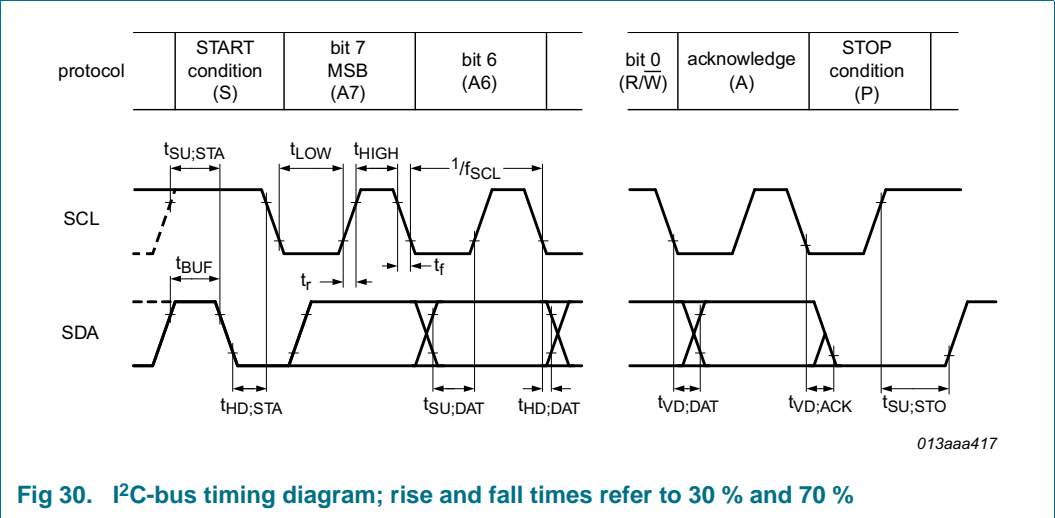
| Symbol       | Parameter   | Conditions | Min                                  | Max | Unit          |
|--------------|---|------------|--------------------------------------|-----|---------------|
| $C_b$        | capacitive load for each bus line                                 |            | -                                    | 400 | pF            |
| $f_{SCL}$    | SCL clock frequency   | [2]        | 0                                    | 400 | kHz           |
| $t_{HD;STA}$ | hold time (repeated) START condition                              |            | 0.6                                  | -   | $\mu\text{s}$ |
| $t_{SU;STA}$ | set-up time for a repeated START condition                        |            | 0.6                                  | -   | $\mu\text{s}$ |
| $t_{LOW}$    | LOW period of the SCL clock                                       |            | 1.3                                  | -   | $\mu\text{s}$ |
| $t_{HIGH}$   | HIGH period of the SCL clock                                      |            | 0.6                                  | -   | $\mu\text{s}$ |
| $t_r$        | rise time of both SDA and SCL signals                             |            | 20                                   | 300 | ns            |
| $t_f$        | fall time of both SDA and SCL signals                             | [3][4]     | $20 \times (V_{DD} / 5.5 \text{ V})$ | 300 | ns            |
| $t_{BUF}$    | bus free time between a STOP and START condition                  |            | 1.3                                  | -   | $\mu\text{s}$ |
| $t_{SU;DAT}$ | data set-up time  |            | 100                                  | -   | ns            |
| $t_{HD;DAT}$ | data hold time  |            | 0                                    | -   | ns            |
| $t_{SU;STO}$ | set-up time for STOP condition                                    |            | 0.6                                  | -   | $\mu\text{s}$ |
| $t_{VD;DAT}$ | data valid time   |            | 0                                    | 0.9 | $\mu\text{s}$ |
| $t_{VD;ACK}$ | data valid acknowledge time                                       |            | 0                                    | 0.9 | $\mu\text{s}$ |
| $t_{SP}$     | pulse width of spikes that must be suppressed by the input filter |            | 0                                    | 50  | ns            |

[1] A detailed description of the I<sup>2</sup>C-bus specification is given in [Ref. 16 "UM10204"](#).

[2] I<sup>2</sup>C-bus access time between two STARTs or between a START and a STOP condition to this device must be less than one second.

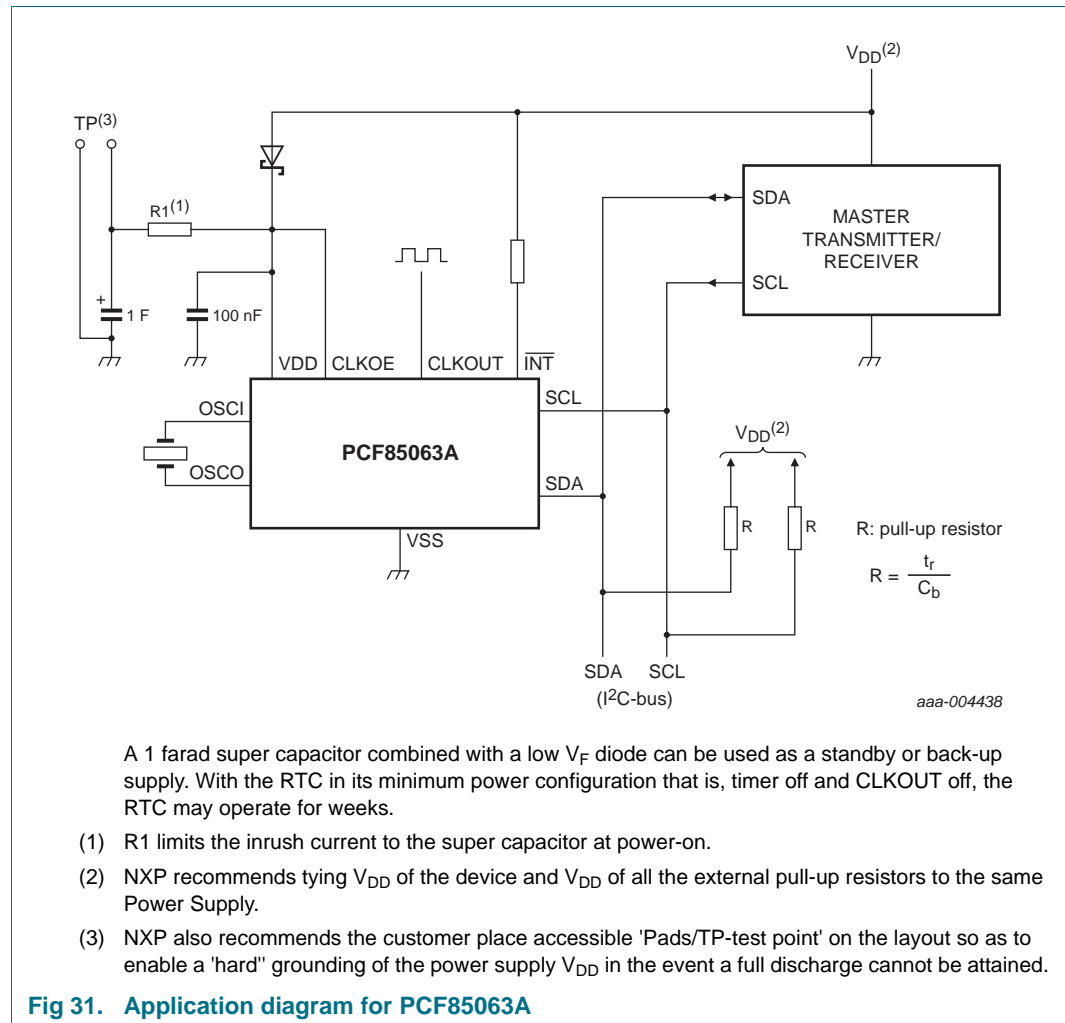
[3] A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the  $V_{IH(min)}$  of the SCL signal) to bridge the undefined region of the falling edge of SCL.

[4] The maximum  $t_f$  for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time for the SDA output stage  $t_f$  is specified at 250 ns. This allows series protection resistors to be connected in between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified  $t_f$ .



## 14. Application information

The data sheet values were obtained using a crystal with an ESR of 60 kΩ. If a crystal with an ESR of 70 kΩ is used then the power consumption would increase by a few nA and the start-up time will increase slightly.



**Fig 31. Application diagram for PCF85063A**

## 15. Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1

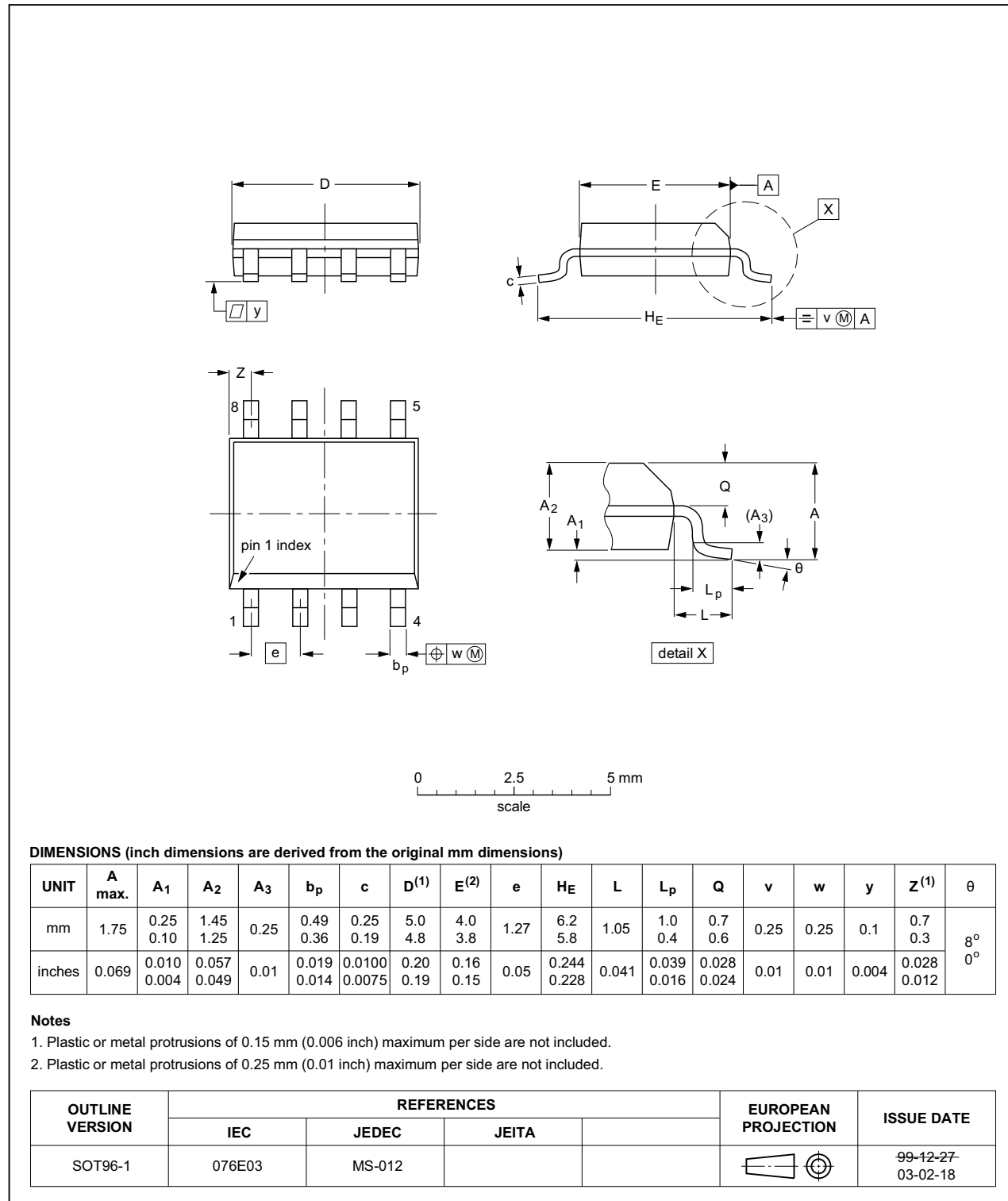


Fig 32. Package outline SOT96-1 (SO8) of PCF85063AT

DFN2626-10: plastic thermal enhanced extremely thin small outline package; no leads;  
10 terminals; body 2.6 x 2.6 x 0.5 mm

SOT1197-1

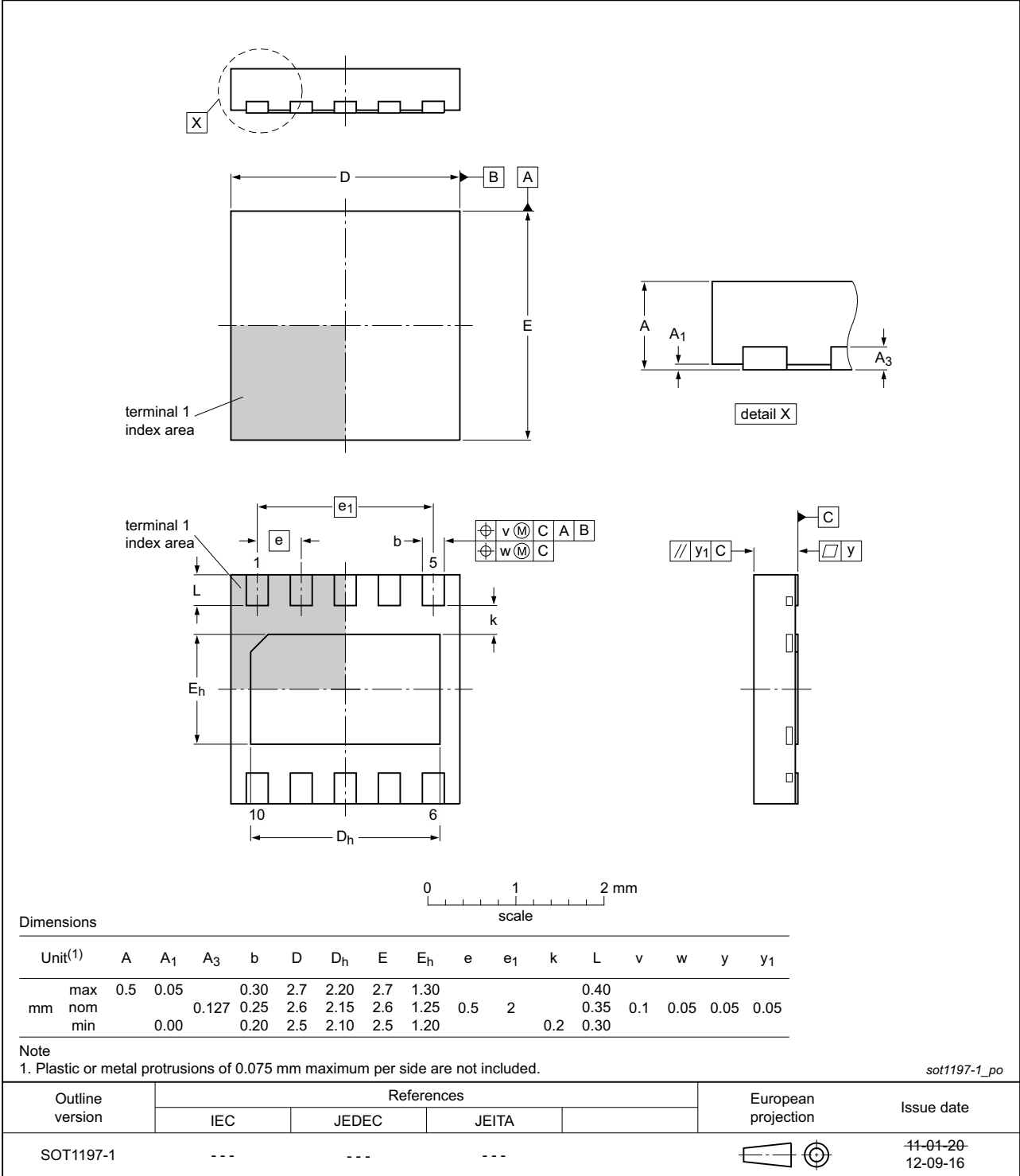


Fig 33. Package outline SOT1197-1 (DFN2626-10) of PCF85063ATL



TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1

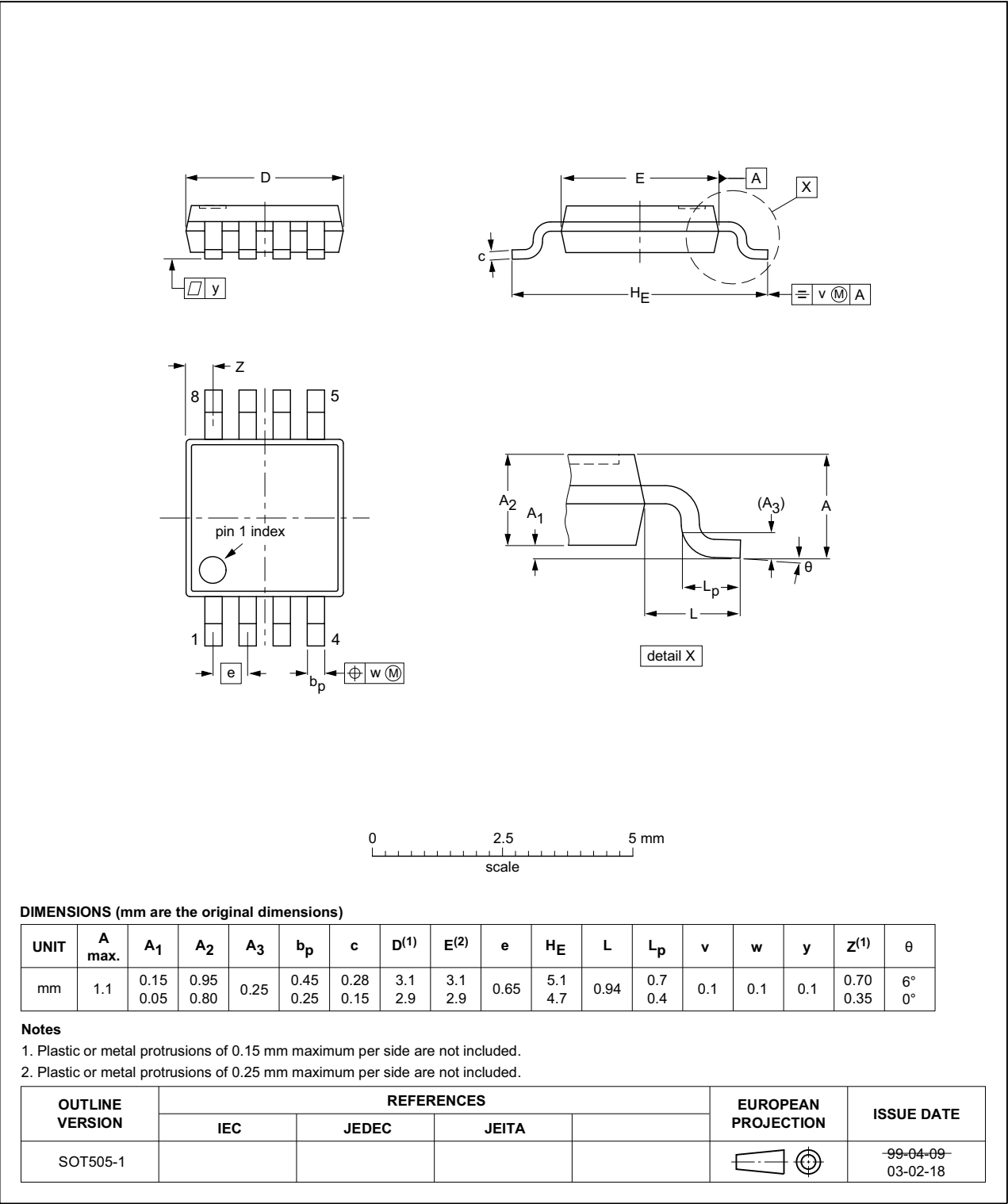


Fig 34. Package outline SOT505-1 (TSSOP8) of PCF85063ATT

## 16. Handling information

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All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

## 17. Packing information

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### 17.1 Tape and reel information

For tape and reel packing information, please see for

PCF85063AT — [Ref. 12 "SOT96-1\\_515"](#) and [Ref. 13 "SOT96-1\\_518"](#)

PCF85063ATL — [Ref. 15 "SOT1197-1\\_115"](#)

PCF85063ATT — [Ref. 14 "SOT505-1\\_118"](#)

## 18. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 18.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 18.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 18.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

## 18.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 35](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 43](#) and [44](#)

**Table 43. SnPb eutectic process (from J-STD-020D)**

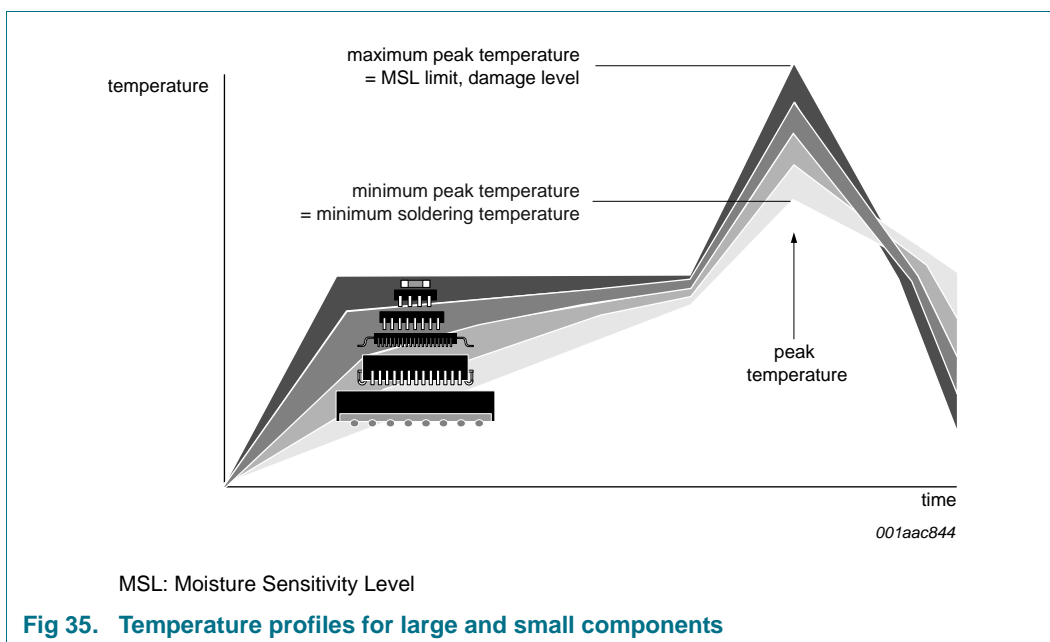
| Package thickness (mm) | Package reflow temperature (°C) |       |
|------------------------|---------------------------------|-------|
|                        | Volume (mm <sup>3</sup> )       |       |
|                        | < 350                           | ≥ 350 |
| < 2.5                  | 235                             | 220   |
| ≥ 2.5                  | 220                             | 220   |

**Table 44. Lead-free process (from J-STD-020D)**

| Package thickness (mm) | Package reflow temperature (°C) |             |        |
|------------------------|---------------------------------|-------------|--------|
|                        | Volume (mm <sup>3</sup> )       |             |        |
|                        | < 350                           | 350 to 2000 | > 2000 |
| < 1.6                  | 260                             | 260         | 260    |
| 1.6 to 2.5             | 260                             | 250         | 245    |
| > 2.5                  | 250                             | 245         | 245    |

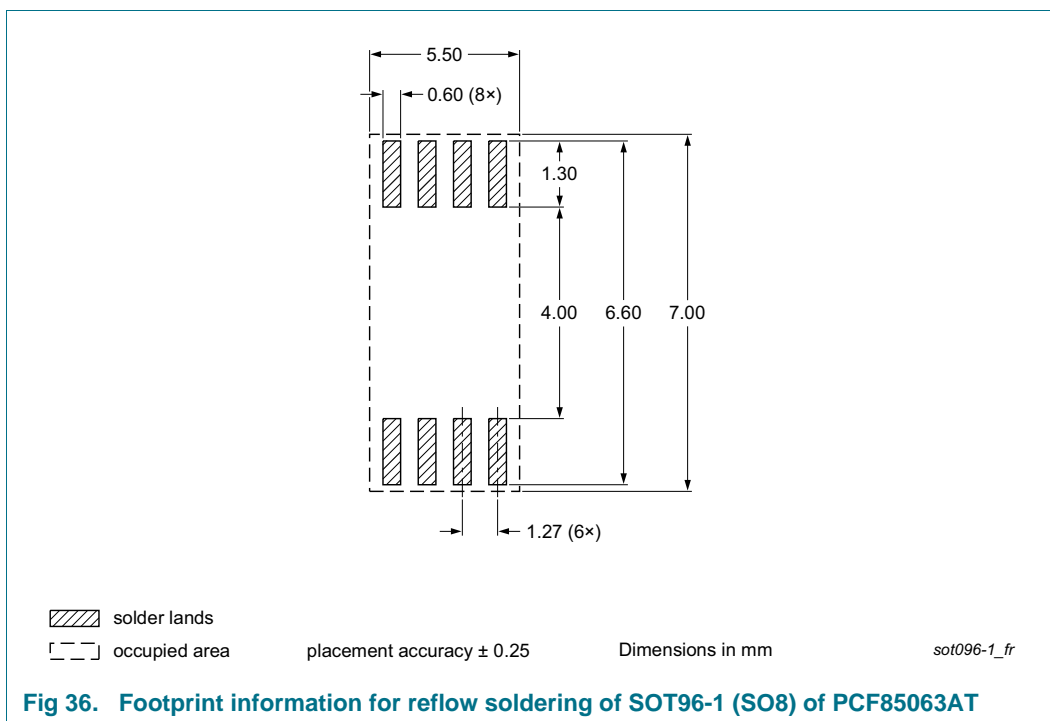
Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 35](#).



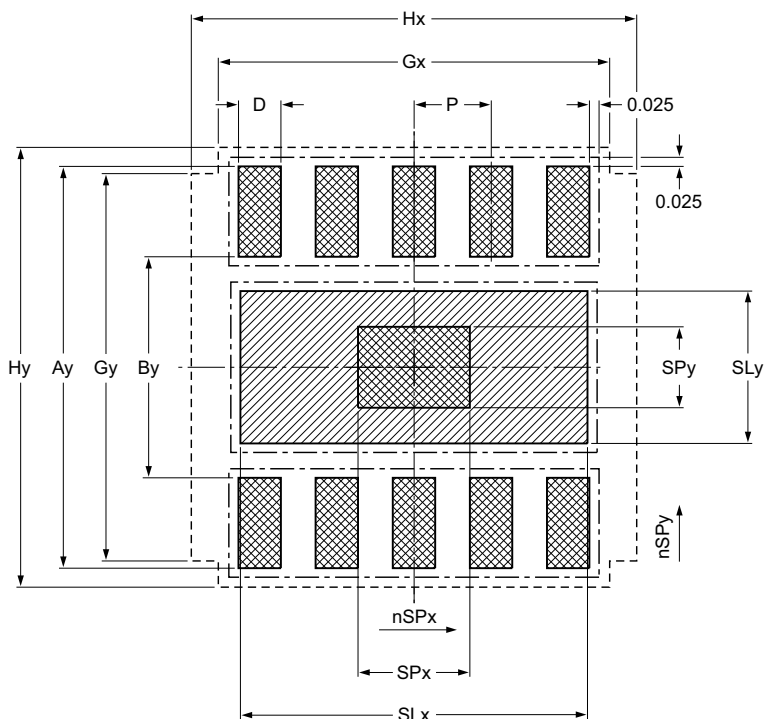
For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

## 19. Footprint information






## Footprint information for reflow soldering of DFN2626-10 package

SOT1197-1



Generic footprint pattern  
Refer to the package outline drawing for actual layout

-  solder land
-  solder paste deposit
-  solder land plus solder paste
- occupied area
- solder resist

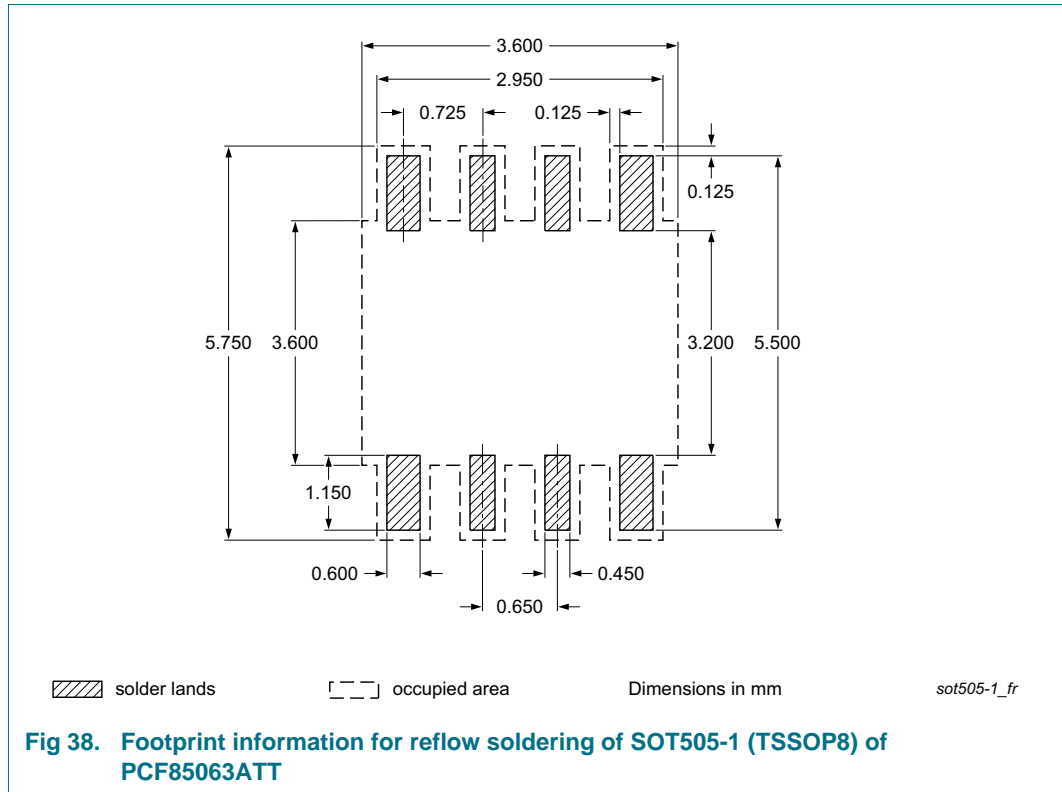
## DIMENSIONS in mm

| P   | Ay   | By  | D    | SLx | SLy | SPx | SPy | Gx  | Gy   | Hx   | Hy  |
|-----|------|-----|------|-----|-----|-----|-----|-----|------|------|-----|
| 0.5 | 3.05 | 1.9 | 0.25 | 2.2 | 1.3 | 0.8 | 0.4 | 2.5 | 2.85 | 2.85 | 3.3 |

Issue date ~~11-07-27~~  
12-09-16

sot1197-1\_fr

Fig 37. Footprint information for reflow soldering of SOT1197-1 (DFN2626-10) of PCF85063ATL



## 20. Appendix

### 20.1 Real-Time Clock selection

Table 45. Selection of Real-Time Clocks

| Type name  | Alarm, Timer, Watchdog | Interrupt output | Interface        | I <sub>DD</sub> , typical (nA) | Battery backup | Timestamp, tamper input | AEC-Q100 compliant | Special features  | Packages                         |
|------------|------------------------|------------------|------------------|--------------------------------|----------------|-------------------------|--------------------|---|----------------------------------|
| PCF85063TP | -                      | 1                | I <sup>2</sup> C | 220                            | -              | -                       | -                  | basic functions only, no alarm                                  | HXSON8                           |
| PCF85063A  | X                      | 1                | I <sup>2</sup> C | 220                            | -              | -                       | -                  | tiny package  | SO8, DFN2626-10, TSSOP8          |
| PCF85063B  | X                      | 1                | SPI              | 220                            | -              | -                       | -                  | tiny package  | DFN2626-10                       |
| PCF85263A  | X                      | 2                | I <sup>2</sup> C | 230                            | X              | X                       | -                  | time stamp, battery backup, stopwatch 1/100 s                   | SO8, TSSOP10, TSSOP8, DFN2626-10 |
| PCF85263B  | X                      | 2                | SPI              | 230                            | X              | X                       | -                  | time stamp, battery backup, stopwatch 1/100s                    | TSSOP10, DFN2626-10              |
| PCF85363A  | X                      | 2                | I <sup>2</sup> C | 230                            | X              | X                       | -                  | time stamp, battery backup, stopwatch 1/100s, 64 Byte RAM       | TSSOP10, TSSOP8, DFN2626-10      |
| PCF85363B  | X                      | 2                | SPI              | 230                            | X              | X                       | -                  | time stamp, battery backup, stopwatch 1/100s, 64 Byte RAM       | TSSOP10, DFN2626-10              |
| PCF2123    | X                      | 1                | SPI              | 100                            | -              | -                       | -                  | lowest power 100 nA in operation                                | TSSOP14, HVQFN16                 |
| PCF8523    | X                      | 2                | I <sup>2</sup> C | 150                            | X              | -                       | -                  | lowest power 150 nA in operation, FM+ 1 MHz                     | SO8, HVSON8, TSSOP14, WLCSP      |
| PCF8563    | X                      | 1                | I <sup>2</sup> C | 250                            | -              | -                       | -                  | -   | SO8, TSSOP8, HVSON10             |
| PCA8565    | X                      | 1                | I <sup>2</sup> C | 600                            | -              | -                       | grade 1            | high robustness, T <sub>amb</sub> = -40 °C to 125 °C            | TSSOP8, HVSON10                  |
| PCA8565A   | X                      | 1                | I <sup>2</sup> C | 600                            | -              | -                       | -                  | integrated oscillator caps, T <sub>amb</sub> = -40 °C to 125 °C | WLCSP                            |
| PCF8564A   | X                      | 1                | I <sup>2</sup> C | 250                            | -              | -                       | -                  | integrated oscillator caps                                      | WLCSP                            |



Table 45. Selection of Real-Time Clocks ...continued

| Type name | Alarm, Timer, Watchdog | Interrupt output | Interface                | I <sub>DD</sub> , typical (nA) | Battery backup | Timestamp, tamper input | AEC-Q100 compliant | Special features   | Packages |
|-----------|------------------------|------------------|--------------------------|--------------------------------|----------------|-------------------------|--------------------|--|----------|
| PCF2127   | X                      | 1                | I <sup>2</sup> C and SPI | 500                            | X              | X                       | -                  | temperature compensated, quartz built in, calibrated, 512 Byte RAM | SO16     |
| PCF2127A  | X                      | 1                | I <sup>2</sup> C and SPI | 500                            | X              | X                       | -                  | temperature compensated, quartz built in, calibrated, 512 Byte RAM | SO20     |
| PCF2129   | X                      | 1                | I <sup>2</sup> C and SPI | 500                            | X              | X                       | -                  | temperature compensated, quartz built in, calibrated               | SO16     |
| PCF2129A  | X                      | 1                | I <sup>2</sup> C and SPI | 500                            | X              | X                       | -                  | temperature compensated, quartz built in, calibrated               | SO20     |
| PCA2129   | X                      | 1                | I <sup>2</sup> C and SPI | 500                            | X              | X                       | grade 3            | temperature compensated, quartz built in, calibrated               | SO16     |
| PCA21125  | X                      | 1                | SPI                      | 820                            | -              | -                       | grade 1            | high robustness, T <sub>amb</sub> = -40 °C to 125 °C               | TSSOP14  |

## 21. Abbreviations

**Table 46. Abbreviations**

| Acronym          | Description                             |
|------------------|---|
| BCD              | Binary Coded Decimal                    |
| CMOS             | Complementary Metal Oxide Semiconductor |
| ESD              | ElectroStatic Discharge                 |
| HBM              | Human Body Model                        |
| I <sup>2</sup> C | Inter-Integrated Circuit                |
| IC               | Integrated Circuit                      |
| LSB              | Least Significant Bit                   |
| MSB              | Most Significant Bit                    |
| MSL              | Moisture Sensitivity Level              |
| PCB              | Printed-Circuit Board                   |
| POR              | Power-On Reset                          |
| RTC              | Real-Time Clock                         |
| SCL              | Serial CLock line                       |
| SDA              | Serial DATa line                        |
| SMD              | Surface Mount Device                    |

## 22. References

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- [1] **AN10365** — Surface mount reflow soldering description
- [2] **AN10366** — HVQFN application information
- [3] **AN11247** — Improved timekeeping accuracy with PCF85063, PCF8523 and PCF2123 using an external temperature sensor
- [4] **IEC 60134** — Rating systems for electronic tubes and valves and analogous semiconductor devices
- [5] **IEC 61340-5** — Protection of electronic devices from electrostatic phenomena
- [6] **IPC/JEDEC J-STD-020** — Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [7] **JESD22-A114** — Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [8] **JESD22-C101** — Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [9] **JESD78** — IC Latch-Up Test
- [10] **JESD625-A** — Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [11] **SNV-FA-01-02** — Marking Formats Integrated Circuits
- [12] **SOT96-1\_515** — SO8; Reel pack; SMD, 7", packing information
- [13] **SOT96-1\_518** — SO8; Reel pack; SMD, 13", packing information
- [14] **SOT505-1\_118** — TSSOP8; Reel pack; SMD, 13", packing information
- [15] **SOT1197-1\_115** — DFN2626-10; Reel pack; SMD, 7", packing information
- [16] **UM10204** — I<sup>2</sup>C-bus specification and user manual
- [17] **UM10301** — User Manual for NXP Real Time Clocks PCF85x3, PCA8565 and PCF2123, PCA2125
- [18] **UM10569** — Store and transport requirements
- [19] **UM10788** — User manual for I<sup>2</sup>C-bus RTC demo board OM13515

## 23. Revision history

Table 47. Revision history

| Document ID     | Release date  | Data sheet status  | Change notice | Supersedes      |
|-----------------|---|--------------------|---------------|-----------------|
| PCF85063A v.7   | 20180330  | Product data sheet | 201801014IU01 | PCF85063A v.6   |
| Modifications:  | <ul style="list-style-type: none"> <li>• <a href="#">Table 4 "Pin description"</a>: Added <a href="#">Table note 2</a> to INT, SDA, and SCL</li> <li>• Added <a href="#">Section 9.5.2.1 "I<sup>2</sup>C-bus error recovery technique"</a></li> <li>• <a href="#">Table 41 "Static characteristics"</a>: Updated <a href="#">Table note 1</a></li> <li>• Updated <a href="#">Figure 31 "Application diagram for PCF85063A"</a>; added <a href="#">Figure note 2</a> and <a href="#">Figure note 3</a></li> <li>• <a href="#">Table 40 "Limiting values[1]"</a>: Added <a href="#">Table note 1</a></li> <li>• Clarified reset information in <a href="#">Section 8.2</a> and <a href="#">Section 8.2.1.3</a>.</li> </ul>  |                    |               |                 |
| PCF85063A v.6   | 20151118  | Product data sheet | -             | PCF85063A v.5   |
| Modifications:  | <ul style="list-style-type: none"> <li>• Updated <a href="#">Table 4 "Pin description"</a> <a href="#">Table note 1</a></li> <li>• Adjusted <a href="#">Section 8.2.2.4</a> paragraph 2</li> <li>• Updated <a href="#">Table 11 "CLKOUT frequency selection"</a> <a href="#">Table note 2</a></li> <li>• <a href="#">Table 41 "Static characteristics"</a>: <ul style="list-style-type: none"> <li>– Corrected <math>V_I</math> min from <math>V_{SS}</math> to <math>-0.5</math> V</li> <li>– Corrected <math>V_{IL}</math> min from <math>V_{SS}</math> to <math>-0.5</math> V</li> <li>– Corrected <math>V_{IH}</math> max from <math>V_{DD}</math> to <math>5.5</math> V</li> <li>– Corrected <a href="#">Table note 1</a></li> <li>– Added <a href="#">Table note 2</a></li> </ul> </li> <li>• Added text to <a href="#">Section 14 "Application information"</a></li> </ul> |                    |               |                 |
| PCF85063A v.5   | 20150506  | Product data sheet | -             | PCF85063A v.4   |
| Modifications:  | <ul style="list-style-type: none"> <li>• Added the 7" reel delivery form for PCF85063AT</li> <li>• Adjusted <a href="#">Section 8.2.2.2</a></li> </ul>  |                    |               |                 |
| PCF85063A v.4   | 20141124  | Product data sheet | -             | PCF85063A v.3   |
| PCF85063A v.3   | 20140604  | Product data sheet | -             | PCF85063A v.2   |
| PCF85063ATL v.2 | 20130415  | Product data sheet | -             | PCF85063ATL v.1 |
| PCF85063ATL v.1 | 20130225  | Product data sheet | -             | -               |

## 24. Legal information

### 24.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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